# 7548 Group

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

#### PRELIMINARY Notice: This is not a final specification. Some parametric limits are subject to change.

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# DESCRIPTION

The 7548 Group is the 8-bit microcomputer based on the 740 family core technology.

The 7548 Group has an 8-bit timer, 16-bit timer, serial interface, A/D converter, power-on reset circuit and the low voltage detection circuit. Also, the Function set ROM is equipped.

# FEATURES

- The minimum instruction execution time ...... 0.25 μs (at 8 MHz oscillation frequency, double-speed mode)

Memory size	
ROM	
RAM	
<ul> <li>Programmable I/O ports</li> </ul>	
I/O port	
Output port	1
Key-on wakeup	6
LED direct drive port	
• Interrupts	. 13 sources, 13 vectors
• Timers	
Output compare	
Input capture	1 channel

Serial interface	8-bit × 1
(UART or clock	synchronous)
• A/D converter 10-bit resolutio	$n \times 6$ -channel
Clock generating circuit	. Built-in type
(connect to external ceramic resonator or quartz-cr	rystal oscillator,
32 kHz quartz-crystal oscill	ation available)
High-speed on-chip oscillator	Typ.: 4 MHz
Low-speed on-chip oscillator	yp. : 250 kHz
Watchdog timer	16-bit × 1
Power-on reset circuit	. Built-in type
Low voltage detection circuit	. Built-in type
Power source voltage	
XIN oscillation frequency	
(at ceramic resonator, in double-speed mode)	
At 8 MHz	4.5 to 5.5 V
At 2 MHz	2.4 to 5.5 V
At 1 MHz	2.2 to 5.5 V
XIN oscillation frequency	
(at ceramic resonator, in high-speed mode)	
At 8 MHz	4.0 to 5.5 V
At 4 MHz	2.4 to 5.5 V
At 1 MHz	1.8 to 5.5 V
High-speed on-chip oscillator oscillation frequent	ncy
At 4 MHz	4.0 to 5.5 V
Low-speed on-chip oscillator oscillation frequer	ncy
At 250 kHz (typ. value at $VCC = 5 V$ ).	1.8 to 5.5 V
Power dissipation	30 mW
Operating temperature range	20 to 85°C

# APPLICATION

Office automation equipment, factory automation equipment, home electric appliances, consumer electronics, etc.







Fig 2. Pin configuration (42S1M type)

# PERFORMANCE OVERVIEW

# Table 1 Performance overview

Parameter		eter	Function		
Number of basic instructions			71		
Instruction execution time			0.25 µs (Minimum instruction, oscillation frequency 8 MHz, double-speed mode		
Oscillation frequenc	V		8 MHz (Maximum)		
Memory sizes ROM M37548G1		M37548G1	2K bytes × 8 bits		
2		M37548G2	4K bytes × 8 bits		
		M37548G3	6K bytes × 8 bits		
	RAM	M37548G1	192 bytes × 8 bits		
		M37548G2	256 bytes × 8 bits		
		M37548G3	256 bytes × 8 bits		
I/O port	P00-P07	1/0	1-bit × 8   ED direct drive ports		
"o port	P10-P15	1/0			
	P20		1-bit × 1		
	D24		1-bit × 1		
Interrunt	FZI Sourco	1/0			
Timor	Source				
Input capture					
Serial interface			8-bit × 1 (UART or clock synchronous)		
A/D converter			10-bit resolution × 6 channel		
Watchdog timer			16-bit × 1		
Power-on reset circl	uit		Built-in		
Low voltage detection	on circuit		Built-in		
Clock generating cir	cuit		Built-in (external ceramic resonator or quartz-crystal oscillator, external 32-kHz quartz-crystal oscillator available) (built-in high/low-speed on-chip oscillator)		
Function set ROM	Function	set ROM	Function set ROM is assigned to address FFD816 to FFDA16.		
area			Valid/invaid of low voltage detection circuit can be selected.		
			Oscillation mode can be selected.		
			Enable/disable of watchdog timer and STP instruction can be selected.		
	ROM co	de protect	ROM code protect is assigned to address FFDB16.		
			to ROM code protect		
Power source	Doublo	at 8 MHz oscillation			
voltage	speed	at 0 MHz oscillation	4.5 10 5.5 V		
(at ceramic	mode	at 2 MHZ OScillation	2.4 to 5.5 V		
resonator)	L P - Is	at 1 MHz oscillation	2.2 10 5.5 V		
	Hign-	at 8 MHz oscillation			
	mode	at 4 MHz oscillation	2.4 to 5.5 V		
_		at 1 MHz oscillation	1.8 to 5.5 V		
Power source	Double-	at 4 MHz oscillation	4.0 to 5.5 V		
voltage	speed				
(at high-speed on-	mode				
Power source	Double-	at 250 kHz oscillation	1.8 to 5.5 V		
voltage					
(at low-speed on-	mode				
chip oscillator)					
Power dissipation			TBD		
Operating temperate	ure range		-20 to 85 °C		
Device structure			CMOS sillicon gate		
Package			20-pin plastic molded SSOP (PLSP0020JB-A)		
			42-pin shrink ceramic PIGGY BACK (42S1M)		



7548 Group

# PIN DESCRIPTION

# Table 2Pin description

Pin	Name	Function			
			Function e	expect a por	t function
Vcc,Vss	Power source	Apply voltage of 1.8 to 5.5 V to Vcc, and 0 V to Vss.			
CNVss	CNVss	Controls the operation mode of the chip. Connected to	v Vss.		
RESET	Reset input	Reset input pin for active "L"			
P00(LED0)/INT0 P01(LED1)/INT1	I/O port P0	<ul><li>•8-bit I/O port.</li><li>•I/O direction register allows each pin to be individu-</li></ul>	Interrupt inp	put pin	
P02(LED2)	ļ	ally programmed as either input or output.			
P03(LED3)/CAP0		•CMOS compatible input level	Capture inp	out pin	
P04(LED4)/RxD P05(LED5)/TxD P06(LED6)/Sclk P07(LED7)/SRDY		<ul> <li>CMOS 3-state output structure</li> <li>Whether a built-in pull-up resistor is to be used or not can be determined by program.</li> <li>High drive capacity for LED drive port can be selected by program.</li> </ul>	Serial interf	face function	ı pin
P10/AN0/KEY0/CMP0 P11/AN1/KEY1/CMP1 P12/AN2/KEY2/CMP2 P13/AN3/KEY3/T2OUT P14/AN4/KEY4 P15/AN5/KEY5	I/O port P1	<ul> <li>•6-bit I/O port.</li> <li>•I/O direction register allows each pin to be individually programmed as either input or output.</li> <li>•CMOS compatible input level</li> <li>•CMOS 3-state output structure</li> <li>•Whether a built-in pull-up resistor is to be used or not can be determined by program.</li> </ul>	Input pins for A/D converter	Key-input (key-on wake up interrupt input) pin	Compare output pin Timer 2 output pin
P20/Xout/Xcout P21/Xin/Xcin (Note)	I/O port P2	<ul> <li>•2-bit I/O port. (P2o/Xout/Xcout is only for output)</li> <li>•I/O direction register allows each pin to be individually programmed as either input or output.</li> <li>•CMOS compatible input level</li> <li>•CMOS 3-state output structure</li> <li>•Function set ROM allows pins to be used as clock pins.</li> </ul>	Pins XIN an and XCOUT, pins by con resonator, o kHz crystal them. Alteri clock may b P20/XOUT/X the P21/XIN as an I/O p	d Xout, or p can be used inecting a ce crystal oscilla oscillator be nately, an ex be input to th Cout pin. In I/Xcin pin car ort.	tins XCIN d as clock rramic ator, or 32 etween ternal ne this case, n be used

NOTE:

 The oscillation circuit is built in the P20/XOUT/XCOUT pin and the P21/XIN/XCIN pin. When the Vcc of the microcomputer is lower than the operation lower bound voltage even if these pins are used as I/O ports, the oscillation circuit is connected and undefined values may be output from these pins.



# Memory Type

Support for QzROM version and emulator MCU.

# Memory Size

٠	ROM size	2 K to 6 K bytes
•	RAM size	192 to 256 bytes

# Packages

- PLSP0020JB-A .... 0.65 mm-pitch 20-pin plastic molded SSOP
- 42S1M ...... 42-pin shrink ceramic PIGGY BACK





Currently supported products are listed below.

# Table 3 List of supported products

Part number	ROM size (bytes) ROM size for User ()	RAM size (bytes)	Package	Remarks
M37548G3-XXXFP	6144	256		QzROM version
M37548G3FP	(6014)	250	FLOF0020JD-A	QzROM version (blank)
M37548G2-XXXFP	4096	256		QzROM version
M37548G2FP	(3966)	250	FLOF0020JD-A	QzROM version (blank)
M37548G1-XXXFP	2048	102		QzROM version
M37548G1FP	(1918)	192	192 FLSF0020JB-A	QzROM version (blank)
M37549RLSS	-	256	42S1M	Emulator MCU

NOTE

1. ROM size includes the function set ROM.



#### FUNCTIONAL DESCRIPTION

#### **Central Processing Unit (CPU)**

The MCU uses the standard 740 family instruction set. Refer to the table of 740 family addressing modes and machine-language instructions or the SERIES 740 <SOFTWARE> USER'S MANUAL for details on each instruction set.

Machine-resident 740 family instructions are as follows:

- 1. The FST and SLW instructions cannot be used.
- 2. The MUL and DIV instructions can be used.
- 3. The WIT instruction can be used.
- 4. The STP instruction can be used.

#### [Accumulator (A)]

The accumulator is an 8-bit register. Data operations such as data transfer, etc., are executed mainly through the accumulator.

#### [Index register X (X), Index register Y (Y)]

Both index register X and index register Y are 8-bit registers. In the index addressing modes, the value of the OPERAND is added to the contents of register X or register Y and specifies the real address.

When the T flag in the processor status register is set to "1", the value contained in index register X becomes the address for the second OPERAND.

#### [Stack Pointer (S)]

The stack pointer is an 8-bit register used during subroutine calls and interrupts. The stack is used to store the current address data and processor status when branching to subroutines or interrupt routines.

The lower eight bits of the stack address are determined by the contents of the stack pointer. The upper eight bits of the stack address are determined by the Stack Page Selection Bit. If the Stack Page Selection Bit is "0", then the RAM in the zero page is used as the stack area. If the Stack Page Selection Bit is "1", then RAM in page 1 is used as the stack area.

The Stack Page Selection Bit is located in the SFR area in the zero page. Note that the initial value of the Stack Page Selection Bit varies with each microcomputer type. Also some microcomputer types have no Stack Page Selection Bit and the upper eight bits of the stack address are fixed. The operations of pushing register contents onto the stack and popping them from the stack are shown in Figure 6.

#### [Program Counter (PC)]

The program counter is a 16-bit counter consisting of two 8-bit registers PCH and PCL. It is used to indicate the address of the next instruction to be executed.



Fig 5. 740 Family CPU register structure





Table 4	Push and pop instructions	of accumulator o	r processor	status register
---------	---------------------------	------------------	-------------	-----------------

	Push instruction to stack	Pop instruction from stack
Accumulator	PHA	PLA
Processor status register	PHP	PLP



#### [Processor status register (PS)]

The processor status register is an 8-bit register consisting of flags which indicate the status of the processor after an arithmetic operation. Branch operations can be performed by testing the Carry (C) flag, Zero (Z) flag, Overflow (V) flag, or the Negative (N) flag. In decimal mode, the Z, V, N flags are not valid.

After reset, the Interrupt disable (I) flag is set to "1", but all other flags are undefined. Since the Index X mode (T) and Decimal mode (D) flags directly affect arithmetic operations, they should be initialized in the beginning of a program.

#### Bit 0: Carry flag (C)

The C flag contains a carry or borrow generated by the arithmetic logic unit (ALU) immediately after an arithmetic operation. It can also be changed by a shift or rotate instruction.

#### Bit 1: Zero flag (Z)

The Z flag is set if the result of an immediate arithmetic operation or a data transfer is "0", and cleared if the result is anything other than "0".

#### Bit 2: Interrupt disable flag (I)

The I flag disables all interrupts except for the interrupt generated by the BRK instruction. Interrupts are disabled when the I flag is "1".

When an interrupt occurs, this flag is automatically set to "1" to prevent other interrupts from interfering until the current interrupt is serviced.

#### Bit 3: Decimal mode flag (D)

The D flag determines whether additions and subtractions are executed in binary or decimal. Binary arithmetic is executed when this flag is "0"; decimal arithmetic is executed when it is "1". Decimal correction is automatic in decimal mode. Only the

ADC and SBC instructions can be used for decimal arithmetic.

#### Bit 4: Break flag (B)

The B flag is used to indicate that the current interrupt was generated by the BRK instruction. The BRK flag in the processor status register is always "0". When the BRK instruction is used to generate an interrupt, the processor status register is pushed onto the stack with the break flag set to "1". The saved processor status is the only place where the break flag is ever set.

#### Bit 5: Index X mode flag (T)

When the T flag is "0", arithmetic operations are performed between accumulator and memory, e.g. the results of an operation between two memory locations is stored in the accumulator. When the T flag is "1", direct arithmetic operations and direct data transfers are enabled between memory locations, i.e. between memory and memory, memory and I/O, and I/O and I/O. In this case, the result of an arithmetic operation performed on data in memory location 1 and memory location 2 is stored in memory location 1. The address of memory location 1 is specified by index register X, and the address of memory location 2 is specified by normal addressing modes.

#### Bit 6: Overflow flag (V)

The V flag is used during the addition or subtraction of one byte of signed data. It is set if the result exceeds +127 to -128. When the BIT instruction is executed, bit 6 of the memory location operated on by the BIT instruction is stored in the overflow flag.

#### Bit 7: Negative flag (N)

The N flag is set if the result of an arithmetic operation or data transfer is negative. When the BIT instruction is executed, bit 7 of the memory location operated on by the BIT instruction is stored in the negative flag.

#### Table 5 Set and clear instructions of each bit of processor status register

	C flag	Z flag	l flag	D flag	B flag	T flag	V flag	N flag
Set instruction	SEC	-	SEI	SED	-	SET	-	—
Clear instruction	CLC	Ι	CLI	CLD	Ι	CLT	CLV	-

# [CPU mode register] CPUM

The CPU mode register contains the stack page selection bit. This register is allocated at address 003B16.



#### Fig 7. Structure of CPU mode register

The processor mode bits can be written only once after releasing reset. Always set them to "002". After written, rewriting any data to these bits is disabled because they are locked. (Emulator MCU is excluded.) Also, the stack page bit (bit 2) is not locked.

In order to prevent error-writing to the processor mode bits (at program runaway), write the CPU mode register at the start of the program that runs after releasing reset.

#### Memory

#### Special Function Register (SFR) Area

The SFR area in the zero page contains control registers such as I/O ports and timers.

#### • RAM

RAM is used for data storage and for a stack area of subroutine calls and interrupts.

#### • ROM

The first 128 bytes and the last 2 bytes of ROM are reserved for device testing and the rest is a user area for storing programs. The user area includes the function set ROM area.

#### Interrupt Vector Area

The interrupt vector area contains reset and interrupt vectors.

#### Zero Page

The 256 bytes from addresses 000016 to 00FF16 are called the zero page area. The internal RAM and the special function registers (SFR) are allocated to this area.

The zero page addressing mode can be used to specify memory and register addresses in the zero page area. Access to this area with only 2 bytes is possible in the zero page addressing mode.

#### Special Page

The 256 bytes from addresses FF0016 to FFFF16 are called the special page area. The special page addressing mode can be used to specify memory addresses in the special page area. Access to this area with only 2 bytes is possible in the special page addressing mode.

#### • Function set ROM Area [Renesas shipment test area]

Figure 8 shows the Assignment of Function set ROM area. The random data are set to the Renesas shipment test areas (addresses FFD416 to address FFD716).

Do not rewrite the data of these areas.

When the checksum is included in the user program, avoid assigning it to these areas.

# [Function set ROM data] FSROM0, FSROM1, FSROM2

Function set ROM data 0 to 2 (addresses FFD816 to FFDA16) are used to set modes of peripheral functions.

By setting values to these areas, the operation mode of each peripheral function are set after releasing reset.

Refer to the descriptions of peripheral functions for the details of operation of peripheral functions.

- Clock circuit
- · Watchdog timer
- · Low voltage detection circuit

# [ROM code protect]

Address FFDB16 of QzROM version is ROM code protect address and cannot be used for programming. "0016" is written into this address when selecting the protect bit write by using a serial programmer and selecting protect enabled for writing shipment by Renesas Technology corp.. When "0016" is set to the ROM code protect address, the protect function is enabled, so that reading or writing from/to the corresponding area is disabled by a serial programmer.

As for the QzROM product in blank, the ROM code is protected by selecting the protect bit write at ROM writing with a serial programmer. As for the QzROM product shipped after writing, "0016" (protect enabled) or "FF16" (protect disabled) is written into the ROM code protect address when Renesas Technology corp. performs writing. The writing of "0016" or "FF16" can be selected as ROM option setup ("MASK option" written in the mask file converter) when ordering.

#### <Notes>

- (1) Because the contents of RAM are indefinite at reset, set initial values before using.
- (2) Do not access to the reserved area.
- (3) Random data is written into the Renesas shipment test area and the reserved ROM area. Do not rewrite the data in these areas. Data of these area may be changed without notice. Accordingly, do not include these areas into programs such as checksum of all ROM areas.
- (4) The QzROM values in function set ROM data 0 to 2 set the operating modes of the various peripheral functions after an MCU reset is released. Do not fail to set the value for the selected function. Bits designated with a fixed value of 1 or 0 must be set to the designated value.







	[		
000016	Port P0 (P0)	002016	Reserved
000116	Port P0 direction register (P0D)	002116	Reserved
000216	Port P1 (P1)	002216	Reserved
000316	Port P1 direction register (P1D)	002316	Reserved
000416	Port P2 (P2)	002416	Reserved
000516	Port P2 direction register (P2D)	002516	Reserved
000616	Port P3 (P3) (Note 1)	002616	Reserved
000716	Port P3 direction register (P3D) (Note 2)	002716	Reserved
000816	Reserved	002816	Prescaler 12 (PRE12)
000916	Reserved	002916	Timer 1 (T1)
000A16	Reserved	002A16	Timer 2 (T2)
000B16	Reserved	002B16	Timer mode register (TM)
000C16	Port P0 drive capacity control register (DCCR)	002C16	Timer count source set register (TCSS)
000D16	Port P0 pull-up control register (PULL0)	002D16	Compare register re-load register (CMPR)
000E16	Port P1 pull-up control register (PULL1)	002E16	Capture/Compare port register (CCPR)
000F16	Key-on wakeup input selection register (KEYS)	002F16	Capture/Compare status register (CCSR)
001016	Capture/Compare register (low-order) (CRAL)	003016	Compare interrupt source set register (CISR)
001116	Capture/Compare register (high-order) (CRAH)	003116	Capture software trigger register (CSTR)
001216	Capture/Compare register R/W pointer (CCRP)	003216	Capture mode register (CAPM)
001316	Compare output mode register (CMOM)	003316	Reserved
001416	Timer A (low-order) (TAL)	003416	AD control register (ADCON)
001516	Timer A (high-order) (TAH)	003516	AD conversion register (low-order) (ADL)
001616	Reserved	003616	AD conversion register (high-order) (ADH)
001716	Reserved	003716	Clock mode register (CLKM)
001816	Transmit/Receive buffer register (TB/RB)	003816	Oscillation stop detection register (CLKSTP)
001916	Serial I/O status register (SIOSTS)	003916	Watchdog timer control register (WDTCON)
001A16	Serial I/O control register (SIOCON)	003A16	Interrupt edge selection register (INTEDGE)
001B16	UART control register (UARTCON)	003B16	CPU mode register (CPUM)
001C16	Baud rate generator (BRG)	003C16	Interrupt request register 1 (IREQ1)
001D16	Reserved	003D16	Interrupt request register 2 (IREQ2)
001E16	Reserved	003E16	Interrupt control register 1 (ICON1)
001F16	Reserved	003F16	Interrupt control register 2 (ICON2)

Notes 1: Port P3 pins are nothing. 2: Set "0316" to the port P3 direction register, though the port P3 pins are nothing. 3: Do not access to the reserved addresses.

Fig 9. Memory map of special function register (SFR)



Fig 10. Structure of Function set ROM data 0



Fig 11. Structure of Function set ROM data 1





# I/O Ports

#### [Direction registers] PiD

The I/O ports have direction registers which determine the input/ output direction of each pin. Each bit in a direction register corresponds to one pin, and each pin can be set to be input or output.

When "1" is set to the bit corresponding to a pin, this pin becomes an output port. When "0" is set to the bit, the pin becomes an input port.

When data is read from a pin set to output, not the value of the pin itself but the value of port latch is read. Pins set to input are floating, and permit reading pin values.

If a pin set to input is written to, only the port latch is written to and the pin remains floating.

- If the port P20 is used as output port, write "1" to the port P20 direction register after reset.
- Set "1" to bits 6 and 7 of the port P1 direction register.
- Set "1" to bits 0 and 1 of the port P3 direction register.

# [Port P0 drive capacity control register] DCCR

By setting the Port P0 drive capacity control register (address 000C16), the drive capacity of the N-channel output transistor for the port P0 can be selected.

# [Pull-up control registers] PULL0, PULL1

By setting the pull-up control registers (address 000D16 and 000E16), ports P0 and P1 can exert pull-up control by program. However, this is valid only when the port direction registers are set to input.

When they are set to output, setting "pull-up on" does not pull up the ports.



# Fig 13. Structure of port P0 drive capacity control register



Fig 14. Structure of port P0 pull-up control register



Fig 15. Structure of port P1 control register



Fig 16. Structure of port P3 direction register

# Table 6 I/O port function table

Pin	Name	I/O format	Non-port function	SFRs related each pin
P00(LED0)/INT0 P01(LED1)/INT1	I/O port P0	CMOS compatible input level CMOS 3-state output	External interrupt input	Interrupt edge selection register Port P0 drive capacity control register Port P0 pull-up control register
P02(LED2)				Port P0 drive capacity control register Port P0 pull-up control register
P03(LED3)/CAP0			Capture input	Capture/Compare port register Port P0 drive capacity control register Port P0 pull-up control register
P04(LED4)/RxD			Serial interface input/ output	Serial I/O control register Port P0 drive capacity control register Port P0 pull-up control register
P05(LED5)/TxD				Serial I/O control register UART control register Port P0 drive capacity control register Port P0 pull-up control register
P06(LED6)/Sclk				Serial I/O control register Port P0 drive capacity control register Port P0 pull-up control register
P07(LED7)/SRDY				Serial I/O control register Port P0 drive capacity control register Port P0 pull-up control register
P10/AN0/KEY0/CMP0 P11/AN1/KEY1/ CMP1P12/AN2/KEY2/ CMP2	I/O port P1		Compare output Key input interrupt A/D conversion input	Capture/Compare port register Port P1 pull-up control register Key-on wakeup input selection register AD control register
P13/AN3/KEY3/T2out			Timer 2 output Key input interrupt A/D conversion input	Timer mode register Port P1 pull-up control register Key-on wakeup input selection register AD control register
P14/AN4/KEY4 P15/AN5/KEY5			Key input interrupt A/D conversion input	Port P1 pull-up control register Key-on wakeup input selection register AD control register
P20/XOUT/XCOUT	I/O port P2	CMOS 3-state output	Clock pin	Function set ROM data 1 (Note) Clock mode register
P21/XIN/XCIN		CMOS compatible input level CMOS 3-state output	Clock pin	Function set ROM data 1 (Note) Clock mode register

NOTE: 1. Function set ROM data 1 is included in the function set ROM area.





Fig 18. Block diagram of pins (2)

#### Termination of unused pins

• Termination of common pins

I/O ports: Select an input port or an output port and follow each processing method.

# Output ports: Open.

Input ports: If the input level become unstable, through current flow to an input circuit, and the power supply current may increase.

Especially, when expecting low consumption current (at STP or WIT instruction execution etc.), pull-up or pull-down input ports to prevent through current (built-in resistor can be used). We recommend processing unused pins through a

resistor which can secure IOH (avg) or IOL (avg). Because, when an I/O port or a pin which have an output function is selected as an input port, it may operate as an output port by incorrect operation etc.

#### Table 7 Termination of unused pins

Pin	Termination
P00/INT0	Perform termination of I/O port.
P01/INT1	
P02	
P03	
P04/RxD	
P05/TxD	
P06/Sclk	
P07/SRDY	
P10/AN0/KEY0/CMP0	
P11/AN1/KEY1/CMP1	
P12/AN2/KEY2/CMP2	
P13/AN3/KEY3/T2out	
P14/AN4/KEY4	
P15/AN5/KEY5	
P20/Xout/Xcout	Set the direction register to "1", and perform termination of output port.
P21/XIN/XCIN	Perform termination of I/O port.

#### Interrupts

Interrupts occur by 13 different sources : 5 external sources, 7 internal sources and 1 software source.

#### Interrupt control

All interrupts except the BRK instruction interrupt have an interrupt request bit and an interrupt enable bit, and they are controlled by the interrupt disable flag. When the interrupt enable bit and the interrupt request bit are set to "1" and the interrupt disable flag is set to "0", an interrupt is accepted.

The interrupt request bit can be cleared by program but not be set.

The interrupt enable bit can be set and cleared by program.

The reset and BRK instruction interrupt can never be disabled with any flag or bit. All interrupts except these are disabled when the interrupt disable flag is set.

When several interrupts occur at the same time, the interrupts are received according to priority.

#### Interrupt operation

Upon acceptance of an interrupt the following operations are automatically performed:

- 1. The processing being executed is stopped.
- 2. The contents of the program counter and processor status register are automatically pushed onto the stack.
- 3. The interrupt disable flag is set and the corresponding interrupt request bit is cleared.
- 4. Concurrently with the push operation, the interrupt destination address is read from the vector table into the program counter.

#### [Interrupt edge selection register] INTEDGE

The valid edge of external interrupt INT<sub>0</sub> and INT<sub>1</sub> can be selected by the interrupt edge selection bit, respectively.

#### [Key-on wakeup input selection register] KEYS

Either of enable or disable of key-on wakeup for pins P10 to P15 can be selected by the key-on wakeup input selection bit, respectively.



Fig 19. Structure of key-on wakeup input selection register

#### Notes on use

(1) When setting the followings, the interrupt request bit may be set to "1".

• When switching external interrupt active edge related register: Interrupt edge selection register (address 003A16) Capture mode register (address 003216)

When not requiring the interrupt occurrence synchronized with these setting, take the following sequence.

- 1. Set the corresponding interrupt enable bit to "0" (disabled).
- 2. Set the interrupt edge select bit (active edge switch bit, trigger mode bit).
- 3. Set the corresponding interrupt request bit to "0" after 1 or more instructions have been executed.
- 4. Set the corresponding interrupt enable bit to "1" (enabled).

Table 8	Interrupt	vector	address	and	priority

Interrupt source	Priority	Vector addresses (Note 1)		Interrupt request generating conditions	Remarks
		High-	Low-		
		order	order		
Reset (Note 2)	1	FFFD16	FFFC16	At reset input	Non-maskable
Serial I/O receive	2	FFFB16	FFFA <sub>16</sub>	At completion of serial I/O data receive	Valid only when serial I/O is selected
Serial I/O transmit	3	FFF916	FFF816	At completion of serial I/O transmit shift or Valid only when serial I/O is selected when transmit buffer is empty	
INT <sub>0</sub>	4	FFF716	FFF616	At detection of either rising or falling edge	External interrupt
				of INTo input	(active edge selectable)
INT <sub>1</sub>	5	FFF516	FFF416	At detection of either rising or falling edge	External interrupt
				of INT1 input	(active edge selectable)
Key-on wakeup	6	FFF316	FFF216	At falling of conjunction of input logical External interrupt (valid at falling edg level for port P1 (at input)	
Capture	7	FFF116	FFF016	At detection of either rising or falling edge of Capture 0 input	External interrupt (active edge selectable)
Compare	8	FFEF16	FFEE16	At compare matched Compare interrupt source is selected.	
Timer A	9	FFED16	FFEC16	At timer A underflow	
Timer 2	10	FFEB16	FFEA <sub>16</sub>	At timer 2 underflow	
A/D conversion	11	FFE916	FFE816	At completion of A/D conversion	
Timer 1	12	FFE716	FFE616	At timer 1 underflow	STP release timer underflow
Not used	13	FFE516	FFE416		
	14	FFE316	FFE216		
	15	FFE116	FFE016		
	16	FFDF16	FFDE16		
BRK instruction	17	FFDD16	FFDC16	At BRK instruction execution	Non-maskable software interrupt

NOTES: 1. Vector addressed contain internal jump destination addresses. 2. Reset function in the same way as an interrupt with the highest priority.







Fig 21. Structure of Interrupt-related registers

#### Key Input Interrupt (Key-On Wakeup)

A key-on wakeup interrupt request is generated by applying "L" level to any pin of port P1 that has been set to input mode. In other words, it is generated when the AND of input level goes from "1" to "0". An example of using a key input interrupt is shown in Figure 22, where an interrupt request is generated by pressing one of the keys provided as an active-low key matrix which uses ports P10 to P13 as input ports.



Fig 22. Connection example when using key input interrupt and port P1 block diagram

#### Timers

The 7548 Group has two 8-bit timers (timer 1 and timer 2) and one 16-bit timer (timer A).

Timer 1 and timer 2 share the same 8-bit prescaler (prescaler 12). Each timer and prescaler has a separate timer latch and prescaler latch.

The division ratio of every timer and prescaler is 1/(n+1), where n is the value of the timer latch or prescaler latch.

The timers decrement at each count clock input. When the count value reaches "0", an underflow occurs at the next count pulse. The value of the corresponding timer latch is reloaded into the timer at underflow and counting is continued. When a timer underflow occurs, the interrupt request bit corresponding to each timer is set to "1".

• Prescaler 12 (PRE12)

Prescaler 12 is an 8-bit prescaler that counts the signal selected by the prescaler 12 count source selection bit. The count source can be selected from  $\phi$ SOURCE/16 and XCIN input clock.

Writing to prescaler 12 writes the value to both the prescaler latch and prescaler.

Reading from prescaler 12 reads the prescaler 12 count value. The initial value is set to "FF16" after reset.

The division ratio of prescaler 12 is 1/(n+1), where n is the setting value.

Prescaler 12 cannot stop counting by software.

• Timer 1 (T1)

Timer 1 is an 8-bit timer that counts the prescaler 12 output.

When Timer 1 underflows, the timer 1 interrupt request bit is set to "1".

Writing to timer 1 writes the value to both the timer 1 latch and timer 1.

Reading from timer 1 reads the timer 1 count value. The initial value is set to "0116" after reset.

The division ratio of timer 1 is 1/(m+1), where m is the setting value. This gives that the division ratio of prescaler 12 and timer 1 is  $1/((n+1) \times (m+1))$ , where n is the prescaler 12 setting value and m is the timer 1 setting value.

Timer 1 cannot stop counting by software.

#### • Timer 2 (T2)

Timer 2 is an 8-bit timer that counts the signal selected by the timer 2 count source selection bit.

The count source can be selected from among  $\phi$ SOURCE/16, /256, prescaler 12 output, and timer A output signal.

Timer 2 counts the selected count source and sets the timer 2 interrupt request bit to "1" at underflow.

When writing to timer 2, the value of the timer 2 write control bit can be used to select a write to both the timer 2 latch and timer 2 or a write to only the timer 2 latch.

Reading from timer 2 reads the timer 2 count value.

Timer 2 starts counting from "FF16" after reset.

The division ratio of timer 2 is 1/(n+1), where n is the timer 2 setting value. Timer 2 stops when the timer 2 count stop bit is set to "1".

When the P13/T2OUT output valid bit is set to "1", the polarity of the waveform output from the P13/T2OUT pin can be inverted at each timer 2 underflow. The output start level of the T2OUT pin can be selected using the T2OUT polarity switch bit. When this bit is set to 0, the output starts at "H" level. When this bit is set to "1", the output starts at "L" level.

# Notes on Timers 1 and 2

 Reading from and Writing to Timer 1 and 2 and Prescaler 12 If the timer/prescaler count source clock and \$OURCE are different clocks, the timers and prescaler cannot be read or written. Select the same clock to enable read and write operations.

Note that timer 2 can be read and written even using a different clock while its counting is stopped.

Prescaler 12 and timer 1 cannot be read/written in the following conditions:
 Prescaler 12 count source: XCIN input clock

**\$SOURCE:** Clock other than XCIN input clock

<sup>(2)</sup> Timer 2 cannot be read/written during counting in the following conditions:

Timer 2 count source: Prescaler 12 Prescaler 12 count source: XCIN input clock \$OURCE: Clock other than XCIN input clock

or

Timer 2 count source: Timer A underflow Timer A count source: XCIN input clock \$OURCE: Clock other than XCIN input clock

or

Timer 2 count source: Timer A underflow

Timer A count source: low-speed on-chip oscillator output

 $\phi$ SOURCE: Clock other than low-speed on-chip oscillator

#### (2) Count Source of Prescaler 12

The XCIN input clock can be selected as the prescaler count source only if the 32 kHz quartz crystal oscillator is selected by the oscillation method selection bit in FSROM1.





Fig 23. Structure of timer mode register





Fig 25. Block diagram of timer 1 and timer 2

# Timer A (TA)

Timer A is a 16-bit timer and counts the signal selected by the timer A count source selection bit.

The count source of Timer A can be selected from among  $\phi$ SOURCE/2, /16, /32, /64, /128, /256, low-speed on-ship oscillator clock, and XCIN input clock.

Timer A counts the selected count source and sets the timer A interrupt request bit to "1".

When writing to timer A, the setting value of the timer A write control bit can be used to select a write to both the timer A latch and timer or a write to only the timer A latch.

Reading from timer A reads the timer A count value.

Be sure to write to and read from the low-order and the higher order of timer A in the following order:

• Read

Read the high-order of Timer A (TAH) first, and the loworder of Timer A (TAL) next. Always read both of the registers.

• Write

Write to the low-order of Timer A (TAL) first and the high-order of Timer A next. Always read both of the registers.

Counting starts from "FFFF16" after reset.

The division ratio of timer A is 1/(n+1), where n is the timer A setting value. Timer A stops when the timer A count stop bit is set to "1".

Timer A can be used as the timing timer for input capture and output compare functions.

# Notes on Timer A

# (1) Timer Value Setting

When the timer A write control bit is set to "write to only latch", written data is written to only to the latch even when the timer is stopped. To set the initial setting value when the timer is stopped, select "Write to timer and latch simultaneously" beforehand.

(2) Reading from and Writing to Timer A

If the timer A count source clock and  $\phi$ SOURCE are different clocks, timer A cannot be read or written during its counting. Select the same clock or set timer A to stop counting to enable read and write operations.

 Timer A cannot be read/written in the following conditions: Timer A count source: XCIN input clock
 \$\$OURCE: Clock other than XCIN input clock or

Timer A count source: Low-speed on-chip oscillator output \$SOURCE: Clock other than low-speed on-chip oscillator

#### (3) Count Source of Timer A

The XCIN input clock can be selected as the count source of timer A only if the 32 kHz quartz crystal oscillator is selected by the oscillation method selection bit in FSROM1.



Fig 26. Block diagram of timer A

#### Output compare

7548 group has 3-output compare channels. Each channel (0 to 2) has the same function and can be used to output waveform by using count value of Timer A.

Three output compare channels share the registers with the input capture (one channel), but their individual circuits operate independently so that all the channels can be used at the same time.

To use each compare channel, set "1" to the compare x (x = 0, 1, 2, 3) output port bit and set the port direction register corresponding to compare channel to output mode.

The compare value for each channel is set to the capture/compare register (low-order) and capture/compare register (high-order).

Writing to the register for each channel is controlled by setting value of capture/compare register RW pointer. Writing to each register is in the following order;

- 1. Set the corresponding compare latch to the capture/compare register RW pointer.
- 2. Write a value to the capture/compare register (low-order) and capture/compare register (high-order). (It doesn't care even if either low-order or high-order is written early.)
- 3. Set "1" to the compare latch y (y = 00, 01, 10, 11, 20, 21) re-load bit.

When "1" is set to the compare latch y re-load bit, the value set to the compare register is loaded to compare latch when the next timer underflow.

After loading, re-load bit is set to "0" automatically.

When the count value of timer A matches the compare latch setting value, a trigger to the compare output circuit is generated. The trigger can be enabled or disabled using the compare x trigger enable bit. When the compare x trigger enable bit is set to 1, the output waveform from the port is as follows.

- When the value of the compare x output level latch is "0" High level at compare latch x0 match Low level at compare latch x1 match
- When the value of the compare x output level latch is "1" Low level at compare latch x0 match
  - High level at compare latch x1 match

The output waveform does not change if the compare x trigger enable bit is set to 0, so the port output remains fixed at high or low level.

The compare output level of each channel can be confirmed by reading the compare x output status bit.

Compare interrupt is available when match of each compare channel and timer count value. The interrupt request from each channel can be disabled or enabled by setting value of compare latch y interrupt source selection bit.

# Notes on Output Compare

- (1) If timer A is stopped, when a value is written to the capture/ compare register it is immediately transferred to the compare latch. In addition, if timer A is stopped and the compare x trigger enable bit is set to "1", the output latch is initialized.
- (2) Do not write the same data to both of compare latch x0 and x1.

(3) When setting value of the compare latch is larger than timer setting value, compare match signal is not generated. Accordingly, the output waveform is fixed to "L" or "H" level.

However, when setting value of another compare latch is smaller than timer setting value, this compare match signal is generated. Accordingly, compare interrupt occurs.

(4) When the compare x trigger enable bit is cleared to "0" (disabled), the match trigger to the waveform output circuit is disabled, and the output waveform can be fixed to "L" or "H" level.

However, in this case, the compare match signal is generated.

Accordingly, compare interrupt occurs.



Fig 27. Structure of capture/compare register



Fig 28. Structure of capture/compare register RW pointer



Fig 29. Structure of compare register re-load register



Fig 30. Structure of capture/compare port register





Fig 31. Structure of compare output mode register



Fig 32. Structure of capture/compare status register



Fig 33. Structure of compare interrupt source register





Fig 34. Block diagram of compare output circuit



Fig 35. Block diagram of compare channel 0



Fig 36. Output compare mode (general waveform)



#### Input capture

7548 group has 1-input capture channel and can be used to capture count value of Timer A.

Input capture shares the registers with three output capture channels, but their individual circuits operate independently so that all the channels can be used at the same time.

To use input capture, set the input capture port selection bits. If P03 is selected, set the P03 direction register to 0. When an input capture trigger is input to the input capture circuit, the count value of timer A is saved to the capture latches. The timer count value at the rising edge of the external input trigger is saved to capture latch 00, and the timer count value at the falling edge of the external input trigger is saved to capture latch 01. Capture latch 00 and capture latch 01 can be read using the following procedure.

- 1. Set the capture/compare register R/W pointer to the read target address.
- 2. Read the high-order bits of the capture/compare registers, then read the low-order bits of the capture/compare registers. (Read both the capture/compare registers in the sequence of high-order bits followed by low-order bits.)

The count value of timer can be retained by software by capture y (y = 00, 01, 10, 11) software trigger bit too. When "1" is set to this bit, count value of timer is retained to the corresponded capture latch.

When reading from the capture y software trigger bit is executed, "0" is read out.

#### Notes on Input Capture

- When the low-speed on-chip oscillator output or XCIN input clock is selected as the count source of timer A, input capture can be used only if the same clock source is selected as  $\phi$ SOURCE and as the count source of timer A.
- When writing "1" to capture y software trigger bit of capture latch 00 and 01 at the same time, or external trigger and software trigger occur simultaneously, if capture latches 00 and 01 are input simultaneously, the set value of capture 0 status bit is undefined.
- When setting the interrupt active edge selection bit and noise filter clock selection bit of capture 0 the interrupt request bit may be set to "1".

When not requiring the interrupt occurrence synchronized with these setting, take the following sequence.

- (1) Set the capture interrupt enable bit to "0" (disabled).
- (2) Set the interrupt edge selection bit or noise filter clock selection bit.
- (3) Set the corresponding interrupt request bit to "0" after 1 or more instructions have been executed.
- (4) Set the capture interrupt enable bit to "1" (enabled).
- When the capture interrupt is used as the interrupt for return from stop mode, set the capture 0 noise filter clock selection bits to "00 (Filter stop)".



Fig 38. Structure of capture software trigger register



Fig 39. Structure of capture mode register



Fig 40. Block diagram of capture channel 0



Fig 41. Capture input waveform (capture interrupt edge selection bit = "rising edge")



Fig 42. Capture input waveform (capture interrupt edge selection bit = "rising and falling edge")

# Serial Interface

#### Serial I/O

#### (1) Clock Synchronous Serial I/O Mode Clock synchronous serial I/O mode can be selected by setting the

Serial I/O can be used as either clock synchronous or asynchronous (UART) serial I/O. A dedicated timer is also provided for baud rate generation.

serial I/O mode selection bit of the serial I/O control register (bit 6) to "1". For clock synchronous serial I/O, the transmitter and the receiver

must use the same clock. If an internal clock is used, transfer is started by a write signal to the TB/RB.



Fig 43. Block diagram of clock synchronous serial I/O



Fig 44. Operation of clock synchronous serial I/O function

#### (2) Asynchronous Serial I/O (UART) Mode

Clock asynchronous serial I/O mode (UART) can be selected by clearing the serial I/O mode selection bit of the serial I/O control register to "0".

Eight serial data transfer formats can be selected, and the transfer formats used by a transmitter and receiver must be identical.

The transmit and receive shift registers each have a buffer, but the two buffers have the same address in memory. Since the shift register cannot be written to or read from directly, transmit data is written to the transmit buffer register, and receive data is read from the receive buffer register.

The transmit buffer register can also hold the next data to be transmitted, and the receive buffer register can hold a character while the next character is being received.



Fig 45. Block diagram of UART serial I/O



#### [Transmit buffer register/receive buffer register (TB/ RB)] 001816

The transmit buffer register and the receive buffer register are located at the same address. The transmit buffer is write-only and the receive buffer is read-only. If a character bit length is 7 bits, the MSB of data stored in the receive buffer is "0".

# [Serial I/O status register (SIOSTS)] 001916

The read-only serial I/O status register consists of seven flags (bits 0 to 6) which indicate the operating status of the serial I/O function and various errors.

Three of the flags (bits 4 to 6) are valid only in UART mode.

The receive buffer full flag (bit 1) is cleared to "0" when the receive buffer register is read.

If there is an error, it is detected at the same time that data is transferred from the receive shift register to the receive buffer register, and the receive buffer full flag is set. A write to the serial I/O status register clears all the error flags OE, PE, FE, and SE (bit 3 to bit 6, respectively). Writing "0" to the serial I/O enable bit SIOE (bit 7 of the serial I/O control register) also clears all the status flags, including the error flags.

Bits 0 to 6 of the serial I/O status register are initialized to "0" at reset, but if the transmit enable bit of the serial I/O control register has been set to "1", the transmit shift completion flag (bit 2) and the transmit buffer empty flag (bit 0) become "1".

# [Serial I/O control register (SIOCON)] 001A16

The serial I/O control register consists of eight control bits for the serial I/O function.

# [UART control register (UARTCON)] 001B16

The UART control register consists of four control bits (bits 0 to 3) which are valid when asynchronous serial I/O is selected and set the data format of an data transfer and one bit (bit 4) which is always valid and sets the output structure of the P05/TxD pin.

#### [Baud rate generator (BRG)] 001C16

The baud rate generator determines the baud rate for serial transfer.

The baud rate generator divides the frequency of the count source by 1/(n + 1), where n is the value written to the baud rate generator.

#### •Notes on Serial I/O

#### · Serial I/O interrupt

When setting the transmit enable bit to "1", the serial I/O transmit interrupt request bit is automatically set to "1". When not requiring the interrupt occurrence synchronized with the transmission enabled, take the following sequence.

- 1. Set the serial I/O transmit interrupt enable bit to "0" (disabled).
- 2. Set the transmit enable bit to "1".
- 3. Set the serial I/O transmit interrupt request bit to "0" after 1 or more instructions have been executed.
- 4. Set the serial I/O transmit interrupt enable bit to "1" (enabled).
- I/O pin function when serial I/O is enabled.

The functions of P06 and P07 are switched with the setting values of a serial I/O mode selection bit and a serial I/O synchronous clock selection bit as follows.

(1) Serial I/O mode selection bit  $\rightarrow$  "1":

Clock synchronous type serial I/O is selected.

Setup of a serial I/O synchronous clock selection bit

"0" : P06 pin turns into an output pin of a synchronous clock.

"1" : P06 pin turns into an input pin of a synchronous clock.

Setup of a SRDY output enable bit (SRDY)

"0" : P07 pin can be used as a normal I/O pin.

"1" : P07 pin turns into a SRDY output pin.

(2) Serial I/O mode selection bit  $\rightarrow$  "0" :

Clock asynchronous (UART) type serial I/O is selected.

Setup of a serial I/O synchronous clock selection bit

"0" : P06 pin can be used as a normal I/O pin.

"1": P06 pin turns into an input pin of an external clock. When clock asynchronous (UART) type serial I/O is selected, it is P07 pin. It can be used as a normal I/O pin.

b7	b0 Serial I/O status register b	7 b0 Serial I/O control register (SIOCON: address 001416 initial value: 0016)
	Transmit buffer empty flag (TBE) 0: Buffer full 1: Buffer empty	BRG count source selection bit (CSS) 0: \$SOURCE 1: \$SOURCE/4
	Receive buffer full flag (RBF) 0: Buffer empty 1: Buffer full Transmit shift completion flag (TSC) 0: Transmit shift inprogress	Serial I/O synchronous clock selection bit (SCS) 0: BRG output divided by 4 when clock synchronous serial I/O is selected, BRG output divided by 16 when UART is selected. 1: External clock input when clock synchronous serial I/O is selected, external clock input divided by 16
	Overrun error flag (OE)	when UART is selected.
	0: No error 1: Overrun error	0: P07 pin operates as ordinary I/O pin 1: P07 pin operates as SRDY output pin
	Parity error flag (PE) 0: No error 1: Parity error	Transmit interrupt source selection bit (TIC) 0: Interrupt when transmit buffer has emptied 1: Interrupt when transmit shift operation is completed
	Framing error flag (FE) 0: No error 1: Framing error	Transmit enable bit (TE) 0: Transmit disabled 1: Transmit enabled
	Summing error flag (SE) 0: (OE) U (PE) U (FE)=0 1: (OE) U (PE) U (FE)=1	Receive enable bit (RE) 0: Receive disabled 1: Receive enabled
	Not used (returns "1" when read)	Serial I/O mode selection bit (SIOM) 0: Clock asynchronous (UART) serial I/O 1: Clock synchronous serial I/O
b7	<ul> <li>UART control register</li> <li>UARTCON: address 001B16, initial value: E016)</li> <li>Character length selection bit (CHAS)</li> <li>0: 8 bits</li> <li>1: 7 bits</li> <li>Parity enable bit (PARE)</li> <li>0: Parity checking disabled</li> <li>1: Parity selection bit (PARS)</li> <li>0: Even parity</li> <li>1: Odd parity</li> <li>Stop bit length selection bit (STPS)</li> </ul>	Serial I/O enable bit (SIOE) 0: Serial I/O disabled (pins P04 to P07 operate as ordinary I/O pins) 1: Serial I/O enabled (pins P04 to P07 operate as serial I/O pins)
	0: 1 stop bit 1: 2 stop bits	
	<ul> <li>PU5/IXD P-channel output disable bit (POFF)</li> <li>0: CMOS output (in output mode)</li> <li>1: N-channel open drain output (in output mode)</li> </ul>	
	— Not used (return "1" when read)	
	Amusture of equiple 1/04 veloted versioners	

Fig 47. Structure of serial I/O1-related registers
#### A/D Converter

The functional blocks of the A/D converter are described below.

#### [AD conversion register] AD

The A/D conversion register is a read-only register that stores the result of A/D conversion. Do not read out this register during an A/D conversion.

#### [AD control register] ADCON

The AD control register controls the A/D converter.

Bit 2 to 0 are analog input pin selection bits.

Bit 3 is the AD conversion clock selection bit. When "0" is set to this bit, the A/D conversion clock is  $\phi$ SOURCE/2 and the A/D conversion time is 122 cycles of  $\phi$ SOURCE. When "1" is set to this bit, the A/D conversion clock is  $\phi$ SOURCE and the A/D conversion time is 61 cycles of  $\phi$ SOURCE.

Bit 4 is the AD conversion completion bit. The value of this bit remains at "0" during A/D conversion, and changes to "1" at completion of A/D conversion.

A/D conversion is started by setting this bit to "0".

#### [Comparison voltage generator]

The comparison voltage generator divides the voltage between Vss and Vcc by 1024, and outputs the divided voltages.

#### [Channel selector]

The channel selector selects one of ports P15/AN5 to P10/AN0, and inputs the voltage to the comparator.

#### [Comparator and control circuit]

The comparator and control circuit compares an analog input voltage with the comparison voltage and stores its result into the AD conversion register. When A/D conversion is completed, the control circuit sets the AD conversion completion bit and the A/D interrupt request bit to "1". Because the comparator is constructed linked to a capacitor, set  $\phi$ SOURCE in order that the A/D conversion clock is 250 kHz or over during A/D conversion.

#### • Notes on A/D converter

As for AD translation accuracy, on the following operating conditions,

accuracy may become low.

- (1) When VCC voltage is lower than [ 3.0 V ], the accuracy at the low temperature may become extremely low compared with that at room temperature. When the system would be used at low temperature, the use at VCC = 3.0 V or more is recommended.
- (2) When XCIN or the low-speed on-chip oscillator is selected as \$\phiSOURCE\$, the A/D converter cannot be used.



Fig 48. Structure of AD control register









Fig 50. Block diagram of A/D converter

#### Watchdog Timer

The watchdog timer gives a means for returning to a reset status when the program fails to run on its normal loop due to a runaway. The watchdog timer consists of an 8-bit watchdog timer H and an 8-bit watchdog timer L, being a 16-bit counter. The operation of the watchdog timer is controlled by bits 2 to "0" in function set ROM data 2 and the watchdog timer control register.

#### · Watchdog timer disable bit

When the watchdog timer disable bit (bit 1 in function set ROM data 2(FSROM2)) is set to "0", the watchdog timer is enabled and starts counting after reset.

Setting this bit to "1" does not operate the watchdog timer.

This bit cannot be rewritten by executing the instruction.

To use the watchdog timer, always set this bit to "0".

After reset, the watchdog timer cannot start counting by a program.

#### Watchdog timer source clock selection bit

The count source of the watchdog timer is selected by the watchdog timer source clock selection bit (bit 0 in FSROM2). This bit cannot be rewritten by executing the instruction.

When this bit is set to "0", the count source is always set to the low-speed on-chip oscillator output/16.

When this bit is set to "1", the count source is set to  $\phi$ SOURCE/ 16.  $\phi$ SOURCE is changed by setting the clock selection bits (bits 5 and 4 in the clock mode register (CLKM: address 003716)).

#### Watchdog timer H count source selection bit

The count source of watchdog timer H is selected by the watchdog timer control register (WDTCON: address 003916). When the watchdog timer H count source selection bit (bit 7 in WDTCON) is set to "0", the count source is set to an underflow signal from watch dog timer L. When this bit is set to "1", the clock selected as the count source of watchdog timer L is input to watchdog timer H.

The initial value of this bit after releasing reset can be set by the bit 2 in FSROM2.

#### Watchdog Timer Operation

Resetting or writing any data to WDTCON sets watchdog timer H to "FF16" and watchdog timer L to "FF16". When the watchdog timer starts, the selected clock is counted and internal reset occurs by the watchdog timer H underflow. Writing to WDTCON is usually programmed to be performed before underflow.

Reading WDTCON reads the values of the high-order 6 bits in the watchdog timer H counter and the watch dog timer count source selection bit. The following shows the time to watchdog timer underflow after writing to the watchdog timer control register.

The example applies when the XIN input clock is selected as  $\phi$ SOURCE and f(XIN) = 8 MHz.

Watchdog timer H count source selection bit = 0: 131.072 ms
Watchdog timer H count source selection bit = 1: 512 μs











#### Notes on Watchdog Timer

 The watchdog timer operates in wait mode. To prevent underflow, write to the watchdog timer control register. The watchdog timer stops in stop mode, but starts counting at the same time as exiting stop mode. After exiting stop mode, it continues counting during oscillation stabilization

time. To prevent underflow during the period, the watchdog timer H count source selection bit (bit 7) in the watchdog timer control register (address 003916) should be set to "0" before executing the STP instruction.

Note that the watchdog timer continues counting even if the STP instruction is executed in the following two conditions:

Stopping the low-speed on-chip oscillator: Disabled (bit 4 in FSROM2)

Source clock of the watchdog timer: Low-speed on-chip oscillator/16 (bit 0 in FSROM2)

② Stopping the low-speed on-chip oscillator: Disabled (bit 4 in FSROM2)

Source clock of the watchdog timer:  $\phi$ SOURCE (bit 0 in FSROM2)

 $\varphi SOURCE$ : Low-speed on-chip oscillator (bits 5 and 4 in CLKM)

(2) STP instruction function selection bit

The function of the STP instruction can be selected by the bit 2 in FSROM2. This bit cannot be used for rewriting by executing the STP instruction.

- When this bit is set to "0", stop mode is entered by executing the STP instruction.
- When this bit is set to "1", internal reset occurs by executing the STP instruction.

Reset can be automatically performed at power on (power-on reset) by the built-in power-on reset circuit.

To use the built-in power-on reset circuit, leave the **RESET** pin open (the pull-up resistor is built-in).

#### Low Voltage Detection Circuit

The built-in low voltage detection circuit is designed to detect a drop in voltage and to reset the microcomputer if the power source voltage drops below a set value (Typ.1.95 V).

The low voltage detection circuit is valid by setting "1" to bit 0 of the function set ROM data 0.

Also, when "1" is set to bit 2 of the function set ROM data 1, the low voltage detection circuit can be valid even in the stop mode. The low voltage detection circuit is stopped in the stop mode by setting "0" to this bit, so that the power dissipation is reduced.



# Fig 54. Operation waveform diagram of power-on reset circuit



Fig 55. Operation waveform diagram of low voltage detection circuit



Fig 56. Timing diagram at reset

2: The content of other registers is undefined when the microcomputer is reset.

4: When the setting by the function set ROM data 2 (FSROM2) is performed,

RENESAS

The initial values must be surely set before you use it. 3: Do not access to the SFR area including nothing.

the initial values of this bit at reset are changed.

Notes 1: X : Undefined

Fig 57. Timing diagram at reset

(1)	Port P0 direction register (P0D)	000116	0016							
(2)	Port P1 direction register (P1D)	000316				00	16			
(3)	Port P2 direction register (P2D)	000516				00	16			
(4)	Port P3 direction register (P3D)	000716				00	16			
(5)	Port P0 drive capacity control register (DCCR)	000C16				00	16			
(6)	Port P0 pull-up control register (PULL0)	000D16				00	16			
(7)	Port P1 pull-up control register (PULL1)	000E16				00	16			
(8)	Key-on wakeup input selection register (KEYS)	000F16				00	16			
(9)	Capture/Compare register (low-order) (CRAL)	001016				00	16			
(10)	Capture/Compare register (high-order) (CRAH)	001116				00	16			
(11)	Capture/Compare register R/W pointer (CCRP)	001216				00	16			
(12)	Compare output mode register (CMOM)	001316				00	16			
(13)	Timer A (low-order) (TAL)	001416				FF	16			
(14)	Timer A (high-order) (TAH)	001516				FF	16			
(15)	Serial I/O status register (SIOSTS)	001916	1	0	0	0	0	0	0	0
(16)	Serial I/O control register (SIOCON)	001A16	0016							
(17)	UART control register (UARTCON)	001B16	1	1	1	0	0	0	0	0
(18)	Prescaler 12 (PRE12)	002816				FF	16			
(19)	Timer 1 (T1)	002916	0	0	0	0	0	0	0	1
(20)	Timer 2 (T2)	002A16	FF16							
(21)	Timer mode register (TM)	002B16		0016						
(22)	Timer count source set register (TCSS)	002C16				00	16			
(23)	Compare register re-load register (CMPR)	002D16				00	16			
(24)	Capture/Compare port register (CCPR)	002E16				00	16			
(25)	Capture/Compare status register (CCSR)	002F16				00	16			
(26)	Compare interrupt source set register (CISR)	003016				00	16			
(27)	Capture software trigger register (CSTR)	003116				00	16			
(28)	Capture mode register (CAPM)	003216				00	16			
(29)	AD control register (ADCON)	003416	0	0	0	1	0	0	0	0
(30)	Clock mode register (CLKM)	003716	0	0	0	0	0	0	1	0
(31)	Oscillation stop detection register (CLKSTP)	003816				00	16			
(32)	Watchdog timer control register (WDTCON)	003916	Note 4	0	1	1	1	1	1	1
(33)	Interrupt edge selection register (INTEDGE)	003A16				00	16			
(34)	CPU mode register (CPUM)	003B16				00	16			
(35)	Interrupt request register 1 (IREQ1)	003C16				00	16			
(36)	Interrupt request register 2 (IREQ2)	003D16				00	16			
(37)	Interrupt control register 1 (ICON1)	003E16		0016						
(38)	Interrupt control register 2 (ICON2)	003F16		0016						

#### PRELIMINARY Notice: This is not a final specification. Some parametric limits are subject to change.

#### **Clock Circuit**

The clock circuit includes the XIN clock (ceramic oscillator or crystal oscillator can be used), XCIN clock (32 kHz oscillator can be used), external clock input, high-speed on-chip oscillator, and low-speed on-chip oscillator.

Pins P20/XOUT/XCOUT and P21/XIN/XCIN can be shared for the ports, XIN oscillation, and XCIN oscillation.

Use the oscillation method selection bits (bits 1 and bit 0 in function set ROM data 1 (FSROM1)) to set the function of these pins.

#### Ceramic Resonator or Crystal Oscillator

Set the oscillation method selection bits (bits 1 and bit 0 in FSROM1) to "012", and connect the resonator (or the oscillator) and external circuit with the shortest wiring length possible.

The constants of the oscillator circuit differ depending on the resonator. Use the values recommended by the resonator manufacturer. (An external feedback resistor may be necessary under some conditions.)

Setting the XIN/XCIN oscillation control bit to "0" starts oscillation. This bit is sets to "0" after reset.

#### 32 kHz Crystal Oscillator

Set the oscillation method selection bits to "102", and connect the 32 kHz crystal oscillator and external circuit with the shortest wiring length possible.

The constants of the oscillator circuit differ depending on the resonator. Use the values recommended by the resonator manufacturer. (An external feedback resistor may be necessary under some conditions.)

Setting the XIN/XCIN oscillation control bit to "0" starts oscillation. This bit is sets to "0" after reset.

#### External Clock Input

Set the oscillation method selection bits to "112", and connect the clock source to the P20/XOUT pin. In this case, the P21/XIN pin can be used as an I/O port.

#### High-Speed On-Chip Oscillator

The high-speed on-chip oscillator is stopped after reset. Setting the high-speed on-chip oscillator oscillation control bit (bit 1 in CLKM) to "0" starts oscillation. This bit is sets to "1" after reset.

#### Low-Speed On-Chip Oscillator

The low-speed on-chip oscillator automatically starts oscillating after reset.

Setting the low-speed on-chip oscillator oscillation control bit (bit 0 in CLKM) to "1" stops oscillator. This bit is sets to "0" after reset. If the low-speed on-chip oscillator control bit (bit 4 in FSROM2) is set to "0" and stopping the low-speed on-chip oscillator is disabled, the low-speed on-chip oscillator oscillation control bit cannot be set to "1" and oscillation cannot be stopped. Also, the oscillator does not stop even when the STP instruction is executed.

# • Using No Oscillator Pins (P20 as output port and P21 as I/O port)

To use only an internal on-chip oscillator, set the oscillation method selection bits to "002". The P20/XOUT pin can be used as an output port and the P21/XIN pin can be used as an I/O port.



Fig 58. Structure of function set ROM data 1







# Fig 60. External circuit of 32 kHz quarts-crystal oscillator



Fig 61. External clock input circuit



b7b0	
Clock mc	de register
CLKM: a	uddress 003716, initial value: 0216)
Low-speed o (Notes 1, 2, 4 0: Oscillation 1: Oscillation	n-chip oscillator oscillation control bit and 4) start stop
High-speed of (Notes 2 and 0: Oscillation 1: Oscillation	n-chip oscillator oscillation control bit 4) start stop
XIN oscillatio 0: Oscillation 1: Oscillation	n control bit (Notes 2 and 4) start stop
Oscillation st STP instruct 0: Timer 1 se automatic 1: Un-automa	abilization time set bit after release of the on it to "0116" and prescaler 12 to "FF16" aliy atically
Clock selecti b5 b4 0 0 : Low-s; 0 1 : High-s 1 0 : XIN/X 1 1 : Not av	on bits (Notes 3 and 4) peed on-chip oscillator peed on-chip oscillator Ni oscillation, External clock ailable
Clock division	n ratio selection bit
0 : \$SOU 0 : \$SOU 1 : \$SOU 1 0 : \$SOU 1 1 : No div	RCE/8 (low-speed mode) RCE/4 (middle-speed mode) RCE/2 (high-speed mode) ision (double-speed mode)
<ul> <li>Notes 1: When stopping the low-speed on-chip os on-chip oscillator control bit (bit 4 in FSR The low-speed on-chip oscillator does n 2: '1' cannot be written to the oscillation or as \$SOURCE by the clock selection bits 3: When 'oscillation pins not used' is set by and 0 in FSROM1), '102' cannot be writt 4: Do not change the values of the clock se bits at the same time using a single instr rewrite these values.</li> </ul>	cillator is disabled by setting the low-speed OM2), "1" cannot be written to this bit. It stop even in stop mode. It is (bits 2 to 0) of the clock selected the oscillation method selection bits (bits 1 en to these bits. Hection bits and the clock oscillation control uction. Always use different instructions to

Fig 62. Structure of clock mode register

#### Note on Clock Circuit

• Switching to XIN/XCIN Oscillator

After a reset is cleared, operation starts using the low-speed onchip oscillator. When switching to XIN/XCIN oscillator, make sure to set a sufficient wait duration with the on-chip oscillator to allow the XIN/XCIN oscillator to stabilize.

#### **Oscillation Control**

#### Clock mode register

Clock mode register contains the oscillation control bits of each oscillation circuits, clock selection bits and etc

#### Clock selection bits

 $\phi$ SOURCE can be selected by the clock selection bits (bits 5 and 4 in clock mode register).  $\phi$ SOURCE can be selected from lowspeed on-chip oscillator, high-speed on-chip oscillator, XIN/XCIN oscillation or external clock input by the clock selection bits.  $\phi$ SOURCE is also used to the clock for peripheral functions. When the oscillation method selection bits (bits 1 and 0 in FSROM1) is set to "002" (oscillation pins not used), setting the clock selection bits to "102" (XIN/XCIN oscillation, external clock input) is disabled.

#### Clock division ratio selection bit

The internal clock  $\phi$  is generated by dividing  $\phi$ SOURCE. Select the division ratio using the clock division ration selection bits (bits 7 and 6 in CLKM).

The division ratio can be selected from among \$SOURCE/8 (low-speed mode), /4 (middle-speed mode), /2 (high-speed mode), and no division (double-speed mode). Table 9 shows the division ratio (mode) settings.

When releasing reset, the low-speed on-chip oscillator is selected as  $\phi$ SOURCE, and  $\phi$ SOURCE/8 is selected as the internal clock. The high-speed on-chip oscillator is stopped at this time. If an oscillation circuit is connected to the clock pin, oscillation starts. To switch  $\phi$ SOURCE to XIN/XCIN oscillation, generate wait time using the on-chip oscillator until the oscillation is stabilized.

		CLKM					FSROM1	FSROM2
∮SOURCE	bit Mode	Clock division ratio selection bits	Clock selection bits	XIN/XCIN oscillation control bit	High-speed on-chip oscillator oscillation control bit	Low-speed on-chip oscillator oscillation control bit	Oscillation method selection bits	Low-speed on- chip oscillator control bit
		Bit 7, 6	Bit 5, 4	Bit 2	Bit 1	Bit 0	Bit 1, 0	Bit 4
Xin	Double-speed	11	10	0	-	-	01	-
	High-speed	10	10	0	-	-	01	-
	Middle-speed	01	10	0	-	-	01	-
	Low-speed	00	10	0	-	-	01	-
XCIN	Double-speed	11	10	0	-	-	10	-
	High-speed	10	10	0	_	-	10	_
_	Middle-speed	01	10	0	_	-	10	_
	Low-speed	00	10	0	_	-	10	_
External	Double-speed	11	10	Ι	_	-	11	_
clock	High-speed	10	10	Ι	_	-	11	_
	Middle-speed	01	10	-	_	-	11	_
	Low-speed	00	10	-	-	-	11	-
High-speed	Double-speed	11	01	-	0	-	_	_
on-chip	High-speed	10	01	-	0	-	_	_
oscillator	Middle-speed	01	01	_	0	-	_	_
	Low-speed	00	01	Ι	0	-	_	_
Low-speed	Double-speed	11	00	-	-	0	-	1/0
on-chip	High-speed	10	00	-	-	0	_	1/0
oscillator	Middle-speed	01	00	_	_	0	_	1/0
	Low-speed	00	00	-	-	0	-	1/0

#### Table 9 Setting the clock division (mode)

-: can be "0" or "1", no change in outcome

#### Stop mode

When the STP instruction is executed, the internal clock  $\phi$  stops at an "H" level and the XIN/XCIN and on-chip oscillator stops. At this time, timer 1 is set to "0116" and prescaler 12 is set to "FF16" when the oscillation stabilization time set bit after release of the STP instruction is "0". On the other hand, timer 1 and prescaler 12 are not set when the above bit is "1". Accordingly, set the wait time fit for the oscillation stabilization time of the oscillator to be used. When an external interrupt is accepted, oscillation is restarted but the internal clock  $\phi$  remains at "H" until timer 1 underflows. As soon as timer 1 underflows, the internal clock  $\phi$ is supplied. This is because when a ceramic resonator is used, some time is required until a start of oscillation. In case oscillation is restarted by reset, no wait time is generated. So apply an "L" level to the RESET pin while oscillation becomes stable, or set the wait time by on-chip oscillator operation after system is released from reset until the oscillation is stabled.

#### Wait mode

If the WIT instruction is executed, the internal clock  $\phi$  stops at an "H" level, but the oscillator does not stop. The internal clock restarts if a reset occurs or when an interrupt is received. Since the oscillator does not stop, normal operation can be started immediately after the clock is restarted. To ensure that interrupts will be received to release the STP or WIT state, interrupt enable bits must be set to "1" before the STP or WIT instruction is executed.

#### Note on Oscillation Control

For use with the oscillation stabilization set bit after release of the STP instruction set to "1", set values in timer 1 and prescaler 12 after fully appreciating the oscillation stabilization time of the oscillator to be used.



Rev.2.00 Mar 15, 2007 Page 47 of 70 REJ03B0210-0200



#### Oscillation stop detection circuit

The oscillation stop detection circuit is used for reset occurrence when a ceramic resonator or RC oscillation circuit stops by disconnection. To use this circuit, set an on-chip oscillator to be in active.

The oscillation stop detection circuit is in active to set "1" to the XIN oscillation stop detection function active bit.

When the oscillation stop detection circuit is enabled, the operation status of the XIN oscillator circuit is monitored using the low-speed on-chip oscillator, and if oscillation stop is detected the oscillation stop detection status bit is set to 1. If additionally the oscillation stop detection reset enable bit is set to "1", an internal reset is triggered when the oscillator stops operating.

The oscillation stop detection status bit is not initialized by an oscillation stop detection reset and retains its value of 1. Since the oscillation stop detection status bit is initialized to "0" by an external reset, it is possible to determine if a reset was due to oscillation stop detection by checking the oscillation stop detection status bit.

The XIN oscillation and external clock input are set as the clocks to detect the oscillation stop.

Refer to the electrical characteristics for the frequencies to detect the oscillation stop.

#### Notes on Oscillation Stop Detection Circuit

(1) Do not execute the transition to "state 2'a" shown in Figure 66 because in this "state 2'a", MCU is stopped without reset even when XIN oscillation is stopped.

- (2) XIN oscillation stop detection function active bit is not cleared by the oscillation stop detection reset. Accordingly, the oscillation stop detection circuit is in active when system is released from internal reset cause of oscillation stop detection.
- (3) Oscillation stop detection status bit is initialized by the following operation.
  - External reset, power-on reset, low voltage detection reset, watchdog timer reset, and reset by STP instruction function
  - Write "0" data to the XIN oscillation stop detection function active bit.
- (4) The oscillation stop detection circuit is not included in the emulator MCU "M37549RLSS".







#### **QzROM Writing Mode**

In the QzROM writing mode, the user ROM area can be rewritten while the microcomputer is mounted on-board by using a serial programmer which is applicable for this microcomputer. Table 10 lists the pin description (QzROM writing mode) and Figure 67 shows the pin connections.

#### Table 10 Pin description (QzROM writing mode)

Refer to Figure 68 and Figure 69 for examples of a connection with a serial programmer.

Contact the manufacturer of your serial programmer for serial programmer.

Refer to the user's manual of your serial programmer for details on how to use it.

Pin	Name	I/O	Function
Vcc, Vss	Power source	Input	Apply 1.8 to 5.5 V to Vcc, and 0 V to Vss.
RESET	Reset input	Input	Reset input pin.
P21 /XIN	Clock input	Input	Set the same termination as the single-chip mode.
P20/XOUT	Clock output	Output	
P00 - P05 P11 - P15	I/O port	I/O	Input "H" or "L" level signal or leave the pin open.
CNVss	VPP input	Input	QzROM programmable power source pin.
P10	ESDA I/O	I/O	Serial data I/O pin.
P06	ESCLK input	Input	Serial clock input pin.
P07	ESPGMB input	Input	Read/program pulse input pin.







Fig 68. When using E8 programmer, connection example



Fig 69. When using programmer of Suisei Electronics System Co., LTD, connection example

#### (1) Processor Status Register

The contents of the processor status register (PS) after reset are undefined except for the interrupt disable flag I which is "1". After reset, initialize flags which affect program execution. In particular, it is essential to initialize the T flag and the D flag because of their effect on calculations.

#### (2) Interrupts

The contents of the interrupt request bit do not change even if the BBC or BBS instruction is executed immediately after they are changed by program because this instruction is executed for the previous contents. For executing the instruction for the changed contents, execute one instruction before executing the BBC or BBS instruction.

#### (3) Decimal Calculations

- For calculations in decimal notation, set the decimal mode flag D to "1", then execute the ADC instruction or SBC instruction. In this case, execute SEC instruction, CLC instruction or CLD instruction after executing one instruction before the ADC instruction or SBC instruction.
- In the decimal mode, the values of the N (negative), V (overflow) and Z (zero) flags are invalid.

#### (4) Ports

The values of the port direction registers cannot be read. That is, it is impossible to use the LDA instruction, memory operation instruction when the T flag is "1", addressing mode using direction register values as qualifiers, and bit test instructions such as BBC and BBS.

It is also impossible to use bit operation instructions such as CLB and SEB and read/modify/write instructions of direction registers for calculations such as ROR.

For setting direction registers, use the LDM instruction, STA instruction, etc.

#### (5) A/D Conversion

Do not execute the STP instruction during A/D conversion.

#### (6) Instruction Execution Timing

The instruction execution time can be obtained by multiplying the frequency of the internal clock  $\phi$  by the number of cycles mentioned in the machine-language instruction table.

The frequency of the internal clock  $\phi$  is the same as that of the  $\phi$ SOURCE in double-speed mode, twice the  $\phi$ SOURCE cycle in high-speed mode, 4 times the  $\phi$ SOURCE cycle in middle-speed mode and 8 times the  $\phi$ SOURCE cycle in low-speed mode.

#### (7) CPU Mode Register

The processor mode bits can be written only once after releasing reset. Always set them to "002". After written, rewriting any data to these bits is disabled because they are locked. (Emulator MCU is excluded.)

Also, the stack page bit (bit 2) is not locked.

In order to prevent error-writing to the processor mode bits (at program runaway), write the CPU mode register at the start of the program that runs after releasing reset.

#### (8) State transition

Do not stop the clock selected as the operation clock because of setting of bits 0 to 2.

#### NOTES ON HARDWARE

#### (1) Handling of Power Source Pin

In order to avoid a latch-up occurrence, connect a capacitor suitable for high frequencies as bypass capacitor between power source pin (VCC pin) and GND pin (Vss pin). A ceramic capacitor of 0.01  $\mu$ F to 0.1  $\mu$ F is recommended.

Connect a capacitor across the power source pin and GND pin with the shortest possible wiring.

#### NOTES ON USE

#### Countermeasures against noise

It is necessary not only design the system taking measures against the noise as follows but to evaluate before actual use.

#### 1. Shortest wiring length

#### (1) Package

Select the smallest possible package to make the total wiring length short.

<Reason>

The wiring length depends on a microcomputer package. Use of a small package, for example QFP and not DIP, makes the total wiring length short to reduce influence of noise.



Fig 70. Selection of packages

#### (2) Wiring for $\overline{\text{RESET}}$ pin

Make the length of wiring which is connected to the  $\overline{\text{RESET}}$  pin as short as possible. Especially, connect a capacitor across the  $\overline{\text{RESET}}$  pin and the Vss pin with the shortest possible wiring (within 20 mm).

#### <Reason>

The width of a pulse input into the  $\overline{\text{RESET}}$  pin is determined by the timing necessary conditions. If noise having a shorter pulse width than the standard is input to the  $\overline{\text{RESET}}$  pin, the reset is released before the internal state of the microcomputer is completely initialized. This may cause a program runaway.





- (3) Wiring for clock input/output pins
  - Make the length of wiring which is connected to clock I/O pins as short as possible.
  - Make the length of wiring (within 20 mm) across the grounding lead of a capacitor which is connected to an oscillator and the VSS pin of a microcomputer as short as possible.
  - Separate the Vss pattern only for oscillation from other Vss patterns.

#### <Reason>

If noise enters clock I/O pins, clock waveforms may be deformed. This may cause a program failure or program runaway. Also, if a potential difference is caused by the noise between the Vss level of a microcomputer and the Vss level of an oscillator, the correct clock will not be input in the microcomputer.



Fig 72. Wiring for clock I/O pins

(4) Wiring to CNVss pin

Connect CNVss pin to a GND pattern at the shortest distance. The GND pattern is required to be as close as possible to the GND supplied to Vss.

In order to improve the noise reduction, to connect a 5 k $\Omega$  resistor serially to the CNVss pin - GND line may be valid.

As well as the above-mentioned, in this case, connect to a GND pattern at the shortest distance. The GND pattern is required to be as close as possible to the GND supplied to Vss.

The CNVss pin of the QzROM is the power source input pin for the built-in QzROM. When programming in the built-in QzROM, the impedance of the CNVss pin is low to allow the electric current for writing flow into the QzROM. Because of this, noise can enter easily. If noise enters the CNVss pin, abnormal instruction codes or data are read from the built-in QzROM, which may cause a program runaway.





and Vcc line

Connect an approximately 0.1  $\mu$ F bypass capacitor across the Vss line and the Vcc line as follows:

- Connect a bypass capacitor across the Vss pin and the Vcc pin at equal length.
- Connect a bypass capacitor across the VSS pin and the VCC pin with the shortest possible wiring.
- Use lines with a larger diameter than other signal lines for Vss line and Vcc line.
- Connect the power source wiring via a bypass capacitor to the Vss pin and the Vcc pin.



Fig 74. Bypass capacitor across the Vss line and the Vcc line

#### 3. Wiring to analog input pins

- Connect an approximately 100  $\Omega$  to 1 k $\Omega$  resistor to an analog signal line which is connected to an analog input pin in series.
- Besides, connect the resistor to the microcomputer as close as possible.
- Connect an approximately 1000 pF capacitor across the Vss pin and the analog input pin. Besides, connect the capacitor to the Vss pin as close as possible. Also, connect the capacitor across the analog input pin and the Vss pin at equal length.

#### <Reason>

Signals which is input in an analog input pin (such as an A/D converter/comparator input pin) are usually output signals from sensor. The sensor which detects a change of event is installed far from the printed circuit board with a microcomputer, the wiring to an analog input pin is longer necessarily. This long wiring functions as an antenna which feeds noise into the microcomputer, which causes noise to an analog input pin.



Fig 75. Analog signal line and a resistor and a capacitor

• The analog input pin is connected to the capacitor of a voltage comparator. Accordingly, sufficient accuracy may not be obtained by the charge/discharge current at the time of A/D conversion when the analog signal source of high-impedance is connected to an analog input pin. In order to obtain the A/D conversion result stabilized more, please lower the impedance of an analog signal source, or add the smoothing capacitor to an analog input pin.

#### 4. Oscillator concerns

Take care to prevent an oscillator that generates clocks for a microcomputer operation from being affected by other signals.

(1) Keeping oscillator away from large current signal lines Install a microcomputer (and especially an oscillator) as far as possible from signal lines where a current larger than the tolerance of current value flows.

<Reason>

In the system using a microcomputer, there are signal lines for controlling motors, LEDs, and thermal heads or others. When a large current flows through those signal lines, strong noise occurs because of mutual inductance.

(2) Installing oscillator away from signal lines where potential levels change frequently

Install an oscillator and a connecting pattern of an oscillator away from signal lines where potential levels change frequently. Also, do not cross such signal lines over the clock lines or the signal lines which are sensitive to noise. <Reason>

Signal lines where potential levels change frequently (such as the CNTR pin signal line) may affect other lines at signal rising edge or falling edge. If such lines cross over a clock line, clock waveforms may be deformed, which causes a microcomputer failure or a program runaway.



Fig 76. Wiring for a large current signal line/Writing of signal lines where potential levels change frequently

#### (3) Oscillator protection using Vss pattern

As for a two-sided printed circuit board, print a VSS pattern on the underside (soldering side) of the position (on the component side) where an oscillator is mounted.

Connect the Vss pattern to the microcomputer Vss pin with the shortest possible wiring. Besides, separate this Vss pattern from other Vss patterns.



Fig 77. Vss pattern on the underside of an oscillator

#### 5. Setup for I/O ports

Setup I/O ports using hardware and software as follows:

<Hardware>

• Connect a resistor of 100  $\Omega$  or more to an I/O port in series.

<Software>

- As for an input port, read data several times by a program for checking whether input levels are equal or not.
- As for an output port, since the output data may reverse because of noise, rewrite data to its port latch at fixed periods.
- Rewrite data to direction registers and pull-up control registers at fixed periods.



Fig 78. Setup for I/O ports

#### 6. Providing of watchdog timer function by software

If a microcomputer runs away because of noise or others, it can be detected by a software watchdog timer and the microcomputer can be reset to normal operation. This is equal to or more effective than program runaway detection by a hardware watchdog timer. The following shows an example of a watchdog timer provided by software.

In the following example, to reset a microcomputer to normal operation, the main routine detects errors of the interrupt processing routine and the interrupt processing routine detects errors of the main routine.

This example assumes that interrupt processing is repeated multiple times in a single main routine processing. <The main routine>

• Assigns a single byte of RAM to a software watchdog timer (SWDT) and writes the initial value N in the SWDT once at each execution of the main routine. The initial value N should satisfy the following condition:

 $N + 1 \ge$  (Counts of interrupt processing executed in each main routine)

As the main routine execution cycle may change because of an interrupt processing or others, the initial value N should have a margin.

- Watches the operation of the interrupt processing routine by comparing the SWDT contents with counts of interrupt processing after the initial value N has been set.
- Detects that the interrupt processing routine has failed and determines to branch to the program initialization routine for recovery processing in the following case:

If the SWDT contents do not change after interrupt processing.

<The interrupt processing routine>

- Decrements the SWDT contents by 1 at each interrupt processing.
- Determines that the main routine operates normally when the SWDT contents are reset to the initial value N at almost fixed cycles (at the fixed interrupt processing count).
- Detects that the main routine has failed and determines to branch to the program initialization routine for recovery processing in the following case:

If the SWDT contents are not initialized to the initial value N but continued to decrement and if they reach 0 or less.



Fig 79. Watchdog timer by software

#### NOTES ON USE

#### Note on Power Source Voltage

When the power source voltage value of a microcomputer is less than the value which is indicated as the recommended operating conditions, the microcomputer does not operate normally and may perform unstable operation.

In a system where the power source voltage drops slowly when the power source voltage drops or the power supply is turned off, reset a microcomputer when the supply voltage is less than the recommended operating conditions and design a system not to cause errors to the system by this unstable operation.

#### Product shipped in blank

As for the product shipped in blank, Renesas does not perform the writing test to user ROM area after the assembly process though the QzROM writing test is performed enough before the assembly process. Therefore, a writing error of approx.0.1 % may occur.

Moreover, please note the contact of cables and foreign bodies on a socket, etc. because a writing environment may cause some writing errors.

#### Overvoltage

Take care not to apply the voltage above the Vcc pin voltage to other pins. Make sure that the voltage of the CNVss pin (VPP power input pin for QzROM) does not change as shown in the bold-lined periods (Figure 80) when powering on and off. If the voltage changes as shown, the QzROM contents may be rewritten.



Fig 80. Timing Diagram (bold-lined periods are applicable)

#### NOTES ON QZROM

#### Notes On QzROM Writing Orders

When ordering the QzROM product shipped after writing, submit the mask file (extension: .mask) which is made by the mask file converter MM.

Be sure to set the ROM option ("MASK option" written in the mask file converter) setup when making the mask file by using the mask file converter MM.

#### Notes On ROM Code Protect

#### (QzROM product shipped after writing)

As for the QZROM product shipped after writing, the ROM code protect is specified according to the ROM option setup data in the mask file which is submitted at ordering.

Renesas Technology corp. write the value of the ROM option setup data in the ROM code protect address (address FFDB16) when writing to the QzROM. As a result, in the contents of the ROM code protect address the ordered value may differ from the actual written value.

The ROM option setup data in the mask file is "0016" for protect enabled or "FF16" for protect disabled. Therefore, the contents of the ROM code protect address (other than the user ROM area) of the QzROM product shipped after writing is "0016" or "FF16".

Note that the mask file which has nothing at the ROM option data or has the data other than "0016" and "FF16" can not be accepted.

#### DATA REQUIRED FOR QZROM WRITING ORDERS

The following are necessary when ordering a QzROM product shipped after writing:

- 1. QzROM Writing Confirmation Form\*
- 2. Mark Specification Form\*
- 3. ROM data ..... Mask file

\* For the QzROM writing confirmation form and the mark specification form, refer to the "Renesas Technology Corp." Homepage (http://www.renesas.com/homepage.jsp).

Note that we cannot deal with special font marking (customer's trademark etc.) in QzROM microcomputer.

#### ELECTRICAL CHARACTERISTICS of 7548 Group

### **Absolute Maximum Ratings**

#### Absolute maximum ratings

Symbol	Parameter	Conditions	Ratings	Unit
Vcc	Power source voltage		-0.3 to 6.5	V
VI	Input voltage P00–P07, P10–P15, P20, P21	All voltages are based	s are based -0.3 to Vcc + 0.3	
VI	Input voltage RESET	When an input voltage	-0.3 to Vcc + 0.3	V
VI	Input voltage CNVss	is measured, output	-0.3 to Vcc + 0.3	V
Vo	Output voltage P00–P07, P10–P15, P20, P21		-0.3 to Vcc + 0.3	V
Pd	Power dissipation	Ta = 25 °C	300	mW
Topr	Operating temperature		–20 to 85	°C
Tstg	Storage temperature		-40 to 125	°C

#### **Recommended Operating Conditions**

#### Recommended operating conditions (1)

(Vcc = 1.8 to 5.5 V, Vss = 0 V, Ta = -20 to 85 °C, unless otherwise noted)

Symbol		Parameter					Unit	
Gymbol			i arameter		Min.	Тур.	Max.	onit
Vcc	Power source	High-speed on-chip oscillator	Double-, high-, middle	-, low-speed mode	4.0	5.0	5.5	V
	voltage	Low-speed on-chip oscillator	Double-, high-, middle	Double-, high-, middle-, low-speed mode		5.0	5.5	V
		XIN oscillation,	Double-speed mode	f(XIN) ≤ 8 MHz	4.5	5.0	5.5	V
		XCIN oscillation, external clock input		$f(XIN) \le 2 MHz$	2.4	5.0	5.5	V
				$f(XIN) \le 1 MHz$	2.2	5.0	5.5	V
			High-, middle-,	$f(XIN) \le 8 MHz$	4.0	5.0	5.5	V
			low-speed mode	$f(XIN) \le 4 MHz$	2.4	5.0	5.5	V
				$f(X_{IN}) \le 1 \text{ MHz}$	1.8	5.0	5.5	V
		XCIN oscillation	Double-, high-, middle-, low-speed mode	$f(Xcin) \le 50 \text{ kHz}$	1.8	5.0	5.5	V
Vss	Power so	urce voltage				0		V
Vih	"H" input voltage (Note 4) P00–P07, P10–P15, P21				0.8Vcc		Vcc	V
Vih	"H" input v	"H" input voltage (Note 5) RESET, XIN, Xcin			0.8Vcc		Vcc	V
VIL	"L" input voltage (Note 4) P00–P07, P10–P15, P21			0		0.2Vcc	V	
VIL	"L" input voltage RESET, CNVss			0		0.2Vcc	V	
VIL	"L" input voltage (Note 5) XIN, XCIN			0		0.16Vcc	V	
$\Sigma$ IOH(peak)	"H" total p P(	eak output current (Note )0–P07, P10–P15, P20, P	s 1, 4) 21				-60	mA
$\Sigma$ IOL(peak)	"L" total p PC	eak output current (Note )0–P07	1)				60	mA
$\Sigma$ IOL(peak)	"L" total p P1	eak output current (Notes 0–P15, P20, P21	s 1, 4)				60	mA
$\Sigma$ IOH(avg)	"H" total a P(	verage output current (N 00–P07, P10–P15, P20, P	lotes 1, 4) 21				-30	mA
$\Sigma$ IOL(avg)	"L" total a P0	verage output current (No 00–P07	ote 1)				30	mA
$\Sigma$ IOL(avg)	"L" total a P1	verage output current (No 0–P15, P20, P21	otes 1, 4)				30	mA
IOH(peak)	"H" peak o P(	output current (Notes 2, 4 00–P07, P10–P15, P20, P	4) 21				-10	mA
IOL(peak)	"L" peak c P(	output current (Notes 2, 4 00–P07 (drive capacity: w	) /eakness), P10–P15, P20,	P21			10	mA
IOL(peak)	"L" peak c P(	output current (Note 2) 00–P07 (drive capacity: st	trength)				30	mA
IOH(avg)	"H" averaç P(	ge output current (Notes 00–P07, P10–P15, P20, P	3, 4) 21				-5	mA
IOL(avg)	"L" averag P(	ge output current (Notes 3 00–P07 (drive capacity: w	3, 4) reakness), P10–P15, P20,	P21			5	mA
IOL(avg)	"L" averag	ge output current (Notes ) 00–P07 (drive capacity: st	3) trength)				15	mA

NOTES:

The total output current is the sum of all the currents flowing through all the applicable ports. The total average current is an average value measured over 100 ms. The total peak current is the peak value of all the currents.
 The peak output current is the peak current flowing in each port.
 The average output current IoL (avg), IOH (avg) in an average value measured over 100 ms.
 P20 and P21 indicates these pins are used as I/O ports.
 XIN and XCIN indicates these pins are used as clock pins.



#### Recommended operating conditions (2)

(Vcc = 1.8 to 5.5 V, Vss = 0 V, Ta = -20 to 85 °C, unless otherwise noted)

Symbol		Parameter				mits	Unit	
Symbol		Falaii	letel		Min.	Тур.	Max.	Onit
f(XIN)	XIN oscillation frequency (Note 1)	XIN oscillation External clock input	Double-speed mode	Vcc = 4.5–5.5 V			8	MHz
				Vcc = 2.4–4.5 V			$\frac{(\text{Vcc}-2.4)\times 2}{0.7}\text{+}2$	MHz
		High-, middle-, low-speed mode		Vcc = 2.2–2.4 V			$\frac{(Vcc - 2.2)}{0.2}$ +1	MHz
			High-, middle-,	Vcc = 4.0–5.5 V			8	MHz
			Vcc = 2.4–4.0 V			$\frac{(Vcc - 2.4)}{0.4}$ +4	MHz	
				Vcc = 1.8–2.4 V			<u>(Vcc - 1.8)</u> 0.2 +1	MHz
	XCIN oscillation frequency (Note 1)	XCIN oscillation	Double-, high-, middle-, low-speed mode	Vcc = 1.8–5.5 V		32.768	50	kHz

NOTE:

1. When the oscillation frequency has a duty cycle of 50 %.



Fig 81. Power source voltage and oscillation frequency

#### **Electrical Characteristics**

#### Electrical characteristics (1)

(Vcc = 1.8 to 5.5 V, Vss = 0 V, Ta = -20 to 85 °C, unless otherwise noted)

Currente e l	Devenueter	Toot conditions		Limits		Linit
Symbol	Parameter	l est conditions	Min.	Тур.	Max.	Unit
Vон	"H" output voltage (Notes 1, 3)	Iон = –5 mA, Vcc = 4.0–5.5 V	Vcc-1.5			V
	F00-F07, F10-F15, F21	Iон = –1.0 mA, Vcc = 1.8–5.5 V	Vcc-1.0			V
Vol	"L" output voltage (Note 1)	IOL = 5 mA, Vcc = 4.0–5.5 V			1.5	V
	P10–P15, P21	IOL = 1.5 mA, Vcc = 4.0–5.5 V			0.3	V
		IoL = 1.0 mA, Vcc = 1.8–5.5 V			1.0	V
Vol	"L" output voltage	IoL = 15 mA, Vcc = 4.0–5.5 V			2.0	V
	F00-F07 (unve capacity, strength)	IOL = 1.5 mA, Vcc = 4.0–5.5 V			0.3	V
		IOL = 1.0 mA, Vcc = 1.8–5.5 V			1.0	V
VT+ – VT-	Hysteresis INT0, INT1, CAP0, P10–P15 (Note 4) RxD, SCLK, RESET			0.5		V
Ін	"H" input current (Note 1) P00–P07, P10–P15, P21	VI = Vcc (Pin floating. Pull up transistors is disable)			5.0	μA
Іін	"H" input current RESET	VI = Vcc			5	μA
Іін	"H" input current (Note 2) XIN	VI = Vcc		4.0		μΑ
Іін	"H" input current (Note 2) XCIN	VI = Vcc		0.5		μΑ
lı∟	"L" input current (Note 1) P00–P07, P10–P15, P21	VI = Vss (Pin floating. Pull up transistors is disable)			-5.0	μA
lı∟	"L" input current RESET	VI = Vss			-0.7	mA
lı∟	"L" input current (Note 2) XIN	VI = Vss		-4.0		μA
lı∟	"L" input current (Note 2) XCIN	VI = Vss		-0.3		μA
lı∟	"L" input current P00–P07, P10–P15	VI = Vss (Pull up transistors is enable)		-0.2	-0.5	mA
Rрн	Pull-up resistor value RESET	VI = Vss		25		kΩ
VRAM	RAM hold voltage	When clock stopped	1.6		5.5	V
RHSOSC	High-speed on-chip oscillator	Vcc = 4.0–5.5 V, Ta = 0–50 °C	TBD	4	TBD	
	osciliation frequency	Vcc = 4.0–5.5 V, Ta = –20–85 °C	TBD	4	TBD	
RLSOSC	Low-speed on-chip oscillator oscillation frequency	Vcc = 5.0 V, Ta = 25 °C	125	250	500	kHz
Dosc	Oscillation stop detection circuit detection frequency	Vcc = 5.0 V, Ta = 25 °C	62.5	150	250	kHz

NOTES: 1. P20 and P21 indicates these pins are used as I/O ports. 2. XIN and XCIN indicates these pins are used as clock pins. 3. P05 is measured when the P05/TxD P-channel output disable bit of the UART1 control register (bit 4 of address 001B16) is "0". 4. It is available only when operating key-on wake up.



# Electrical characteristics (2) (Vcc = 1.8 to 5.5 V, Vss = 0 V, Ta = -20 to 85 °C, unless otherwise noted)

Symbol	Parameter	Test condition			Limits		Unit	
Symbol	Parameter		15	Min.	Тур.	Max.	Unit	
Icc	Power	High-speed on-chip oscillator: oscillation · Vcc = 5.0 V	Double-speed mode		2.5	5.2	mA	
	current	<ul> <li>Low-speed on-chip oscillator: stop</li> <li>XIN: stop</li> </ul>	Low-speed mode		0.6	1.7	mA	
		Output transistors "off"     Low voltage detection circuit: enable	Wait mode, functions except timer 1 disabled		0.35	1.0	mA	
		Low-speed on-chip oscillator: oscillation · Vcc = 5.0 V	Double-speed mode		230	600	μΑ	
		High-speed on-chip oscillator: stop     XIN: stop	Low-speed mode		120	400	μΑ	
		Output transistors "off"     Low voltage detection circuit: enable	Wait mode, functions except timer 1 disabled		105	350	μΑ	
		f(XIN)=8 MHz (ceramic resonator) · Vcc = 5.0 V	Double-speed mode		6.0	10	mA	
		High-speed on-chip oscillator: stop     Low-speed on-chip oscillator: stop	Low-speed mode		2.6	6.0	mA	
		Courput transistors for     Courput ttal     Courput transistors for     Courputt	Wait mode, functions except timer 1 disabled		1.9	5.0	mA	
		f(XCIN)=32.768 kHz · Vcc = 5.0 V	Double-speed mode		100	200	μΑ	
		High-speed on-chip oscillator: stop     Low-speed on-chip oscillator: stop     Quitaut transitions "off"	Low-speed mode		85	180	μA	
		Courput transistors for     Courput ttal     Courput transistors for     Courputt	Wait mode, functions except timer 1 disabled		80	170	μA	
		Low-speed on-chip oscillator: oscillation · Vcc = 2.0 V · High-speed on-chip oscillator: stop · XIN: stop · Output transistors "off" · Low voltage detection circuit: enable	Low-speed mode		25	70	μΑ	
			Wait mode, functions except timer 1 disabled		23	60	μΑ	
		f(XIN) = 2 MHz (ceramic resonator) · Vcc = 2.0 V · High-speed on-chip oscillator: stop	Low-speed mode		190	450	μΑ	
		Low-speed on-chip oscillator: stop     Output transistors "off"     Low voltage detection circuit: enable	Wait mode, functions except timer 1 disabled		150	430	μΑ	
		f(XciN) = 32.768 kHz · Vcc = 2.0 V · High-speed on-chip oscillator: stop	Low-speed mode		24	65	μA	
		Low-speed on-chip oscillator: stop     Output transistors "off"     Low voltage detection circuit: enable	Wait mode, functions except timer 1 disabled		23	55	μΑ	
		Low voltage detection circuit self consumption current	Ta = 25 °C Vcc = 5.0 V		70		μA	
			Ta = 25 °C Vcc = 2.0 V		20		μA	
		Increment when A/D conversion is executed f(XIN) = 8 MHz, Vcc = 5.0 V	d		0.5		mA	
		Stop mode · Output transistors "off"	Ta = 25 °C		0.1	1.0	μΑ	
		Low-speed on-chip oscillator: stop     Low voltage detection circuit: stop	Ta = 85 °C			10	μA	

#### A/D Converter Characteristics

#### A/D Converter characteristics

(Vcc = 2.7 to 5.5 V, Vss = 0 V, Ta = -20 to 85 °C, unless otherwise noted)

Currents al	Parameter						
Symbol	Parameter	Test conditions	Min. Typ.		Max.	Unit	
	Resolution				10	bits	
	Absolute accuracy (excluding quantization error)	Ta = $-20-85$ °C, $2.7 \le Vcc \le 5.5$ V			TBD	LSB	
toonu	Conversion time	A/D conversion clock = $f(\phi SOURCE)/2$			122	tc(	
ICONV		A/D conversion clock = $f(\phi SOURCE)$			61	tc(	
RLADDER	Ladder resistor			55		kΩ	
li(AD)	A/D port input current				5.0	μΑ	

### A/D Converter Recommended Operating Conditions

(Vcc = 2.7 to 5.5 V, Vss = 0 V, Ta = -20 to 85 °C, unless otherwise noted)

Cumphel	Deveryoten	Test conditions		Linit			
Symbol			Min.	Тур.	Max.	Unit	
Vcc	Power source voltage	Ta = –20–85 °C	2.7		5.5	V	
φ(AD)	A/D conversion clock	$4.0 \leq Vcc \leq 5.5 V$	TBD		8	MHz	
	frequency (Note)	$2.7 \leq Vcc < 4.0 V$	TBD		4	MHz	

NOTE:

1. When XCIN or the low-speed on-chip oscillator is selected as  $\phi$ SOURCE, the A/D converter cannot be used.

#### Power-on reset circuit characteristics

#### Power-on reset circuit characteristics

(Vcc = 1.8 to 5.5 V, Vss = 0 V, Ta = -20 to 85 °C, unless otherwise noted)

Cumhal	Deremeter	Test conditions		Unit		
Symbol	Parameter	Test conditions	Min.	Тур.	Max. 0 10 20	Unit
VPOR	Valid start voltage of power-on reset circuit (Note)				0	V
TW(VPOR)	VPOR hold time				10	S
TW(VPOR-VDET)	Rising time of valid power source of power-on reset circuit	TW(VPOR) > 10 s			20	ms

NOTE:

1.

VPOR is the start voltage level of Vcc for the built-in power-on reset circuit to operate normally. Keep VPOR to be lower than the Vcc voltage before rising of the Vcc power source to use the built-in power-on reset circuit. Set the built-in low voltage detection circuit to be valid when the built-in power-on reset is used.

#### Low voltage detection circuit characteristics

#### Low voltage detection circuit characteristics

(Vcc = 1.8 to 5.5 V, Vss = 0 V, Ta = -20 to 85 °C, unless otherwise noted)

Cumhal	Parameter	Test conditions		Linit		
Symbol		Test conditions	Min.	Тур.	Max.	Unit
Vlvd	Valid start voltage of low voltage detection circuit (Note)					V
TW(VLVD)	VLVD hold time				10	S
TW(VLVD-VDET)	Rising time of valid power source of low voltage detection circuit	TW(VLVD) > 10 s			10	s
VDET	Detection voltage of low voltage detection circuit	Ta = 0–50 °C	1.85	1.95	2.05	V
		Ta = -20-85 °C	1.80	1.95	2.10	V
V(VDET+- VDET-)	Detection voltage Hysteresis (when hysteresis is valid)	Ta = -20-85 °C		0.10		V
TDET	Detection time of low 5voltage detection circuit         20					μs

NOTE: 1. VLVD is the start voltage level of Vcc for the built-in low voltage detection circuit to operate normally. If the Vcc power source becomes lower than VLVD, first set the Vcc voltage to be lower than VPOR. Next, according to the electrical characteristics of the power-on reset circuit, perform the rising of Vcc.



Fig 82. Electrical characteristics of power-on reset circuit and voltage drop detection circuit

#### **Timing Requirements**

#### Timing requirements (1)

(Vcc = 4.0 to 5.5 V, Vss = 0 V, Ta = -20 to 85 °C, unless otherwise noted)

Symbol	Parameter		Limits				
			Тур.	Max.	Unit		
tw(RESET)	Reset input "L" pulse width	2			μs		
tc(XIN)	External clock input cycle time	125			ns		
twh(Xin)	External clock input "H" pulse width 50						
twL(XIN)	External clock input "L" pulse width 50						
twh(INTo)	INT0, INT1, CAP0 input "H" pulse width (Note 1)	80			ns		
tw∟(INT₀)	INTo, INT1, CAPo input "L" pulse width (Note 1) 80						
tC(SCLK)	Serial I/O clock input cycle time (Note 2) 800						
twh(Sclk)	Serial I/O clock input "H" pulse width (Note 2)	370			ns		
twL(SCLK)	Serial I/O clock input "L" pulse width (Note 2)	370			ns		
tsu(RXD-SCLK)	) Serial I/O input set up time 220						
th(SCLK-RXD)	Serial I/O input hold time 100						

NOTES:

As for CAP0, it is the value when noise filter is not used.
 In this time, bit 6 of the serial I/O control register (address 001A16) is set to "1" (clock synchronous serial I/O is selected). When bit 6 of the serial I/O control register is "0" (clock asynchronous serial I/O is selected), the rating values are divided by 4.

#### Timing requirements (2)

(Vcc = 2.4 to 5.5 V, Vss = 0 V, Ta = -20 to 85 °C, unless otherwise noted)

Symbol	Description		1.1				
	Parameter		Тур.	Max.	Unit		
tw(RESET)	Reset input "L" pulse width	2			μS		
tc(XIN)	External clock input cycle time	250			ns		
twh(Xin)	External clock input "H" pulse width 100						
twl(Xin)	External clock input "L" pulse width	100					
twн(INTo)	INT0, INT1, CAP0 input "H" pulse width (Note 1) 230						
twL(INT0)	INTo, INT1, CAPo input "L" pulse width (Note 1) 230						
tC(SCLK)	Serial I/O clock input cycle time (Note 2)	2000					
twh(Sclk)	Serial I/O clock input "H" pulse width (Note 2)	950			ns		
twL(SCLK)	Serial I/O clock input "L" pulse width (Note 2)	950			ns		
tsu(RXD-SCLK)	Serial I/O input set up time	erial I/O input set up time 400					
th(SCLK-RXD)	Serial I/O input hold time	200					

NOTES:

As for CAP0, it is the value when noise filter is not used.
 In this time, bit 6 of the serial I/O control register (address 001A16) is set to "1" (clock synchronous serial I/O is selected). When bit 6 of the serial I/O control register is "0" (clock asynchronous serial I/O is selected), the rating values are divided by 4.

Timing requirements (3) (Vcc = 1.8 to 5.5 V, Vss = 0 V, Ta = -20 to 85 °C, unless otherwise noted)

Symbol	Deservation		L I wit					
	Parameter		Тур.	Max.	Unit			
tw(RESET)	Reset input "L" pulse width	2			μS			
tc(XIN)	External clock input cycle time	500			ns			
twh(Xin)	External clock input "H" pulse width 200							
twl(Xin)	External clock input "L" pulse width	pulse width 200						
twн(INTo)	INT0, INT1, CAP0 input "H" pulse width (Note 1) 460							
twL(INT0)	NT0, INT1, CAP0 input "L" pulse width (Note 1) 460							
tc(Sclk)	Serial I/O clock input cycle time (Note 2)	4000						
tWH(SCLK)	Serial I/O clock input "H" pulse width (Note 2)	1900						
twL(SCLK)	Serial I/O clock input "L" pulse width (Note 2)	1900						
tsu(RXD-SCLK)	Serial I/O input set up time	800						
th(SCLK-RXD)	Serial I/O input hold time	400						

NOTES:
1. As for CAP0, it is the value when noise filter is not used.
2. In this time, bit 6 of the serial I/O control register (address 001A16) is set to "1" (clock synchronous serial I/O is selected). When bit 6 of the serial I/O control register is "0" (clock asynchronous serial I/O is selected), the rating values are divided by 4.

#### **Switching Characteristics**

#### Switching characteristics (1)

(Vcc = 4.0 to 5.5 V, Vss = 0 V, Ta = -20 to 85 °C, unless otherwise noted)

Symbol	Deremeter		Linit			
	Farameter	Min.	Тур.	Max.	Unit	
tWH(SCLK)	Serial I/O clock output "H" pulse width	tc(Sclк)/2–30			ns	
tWL(SCLK)	Serial I/O clock output "L" pulse width			ns		
td(SCLK-TXD)	Serial I/O output delay time					
tv(Sclк-TxD)	Serial I/O output valid time	-30			ns	
tr(SCLK)	Serial I/O clock output rising time			30	ns	
tf(SCLK)	Serial I/O clock output falling time			30	ns	
tr(CMOS)	CMOS output rising time (Note 1)		10	30	ns	
tf(CMOS)	CMOS output falling time (Note 1)     10     30					

NOTE:

### 1. Pin Xout is excluded.

# Switching characteristics (2) (Vcc = 2.4 to 5.5 V, Vss = 0 V, Ta = -20 to 85 °C, unless otherwise noted)

Curren el	Deremeter		Linit				
Symbol	Parameter	Min.	Тур.	Max.	Unit		
twн(ScLk)	Serial I/O clock output "H" pulse width tc(ScLK)/2–50						
twL(SCLK)	Serial I/O clock output "L" pulse width tc(ScLK)/2–50						
td(SCLK-TXD)	Serial I/O output delay time			350	ns		
tv(Sclk-TxD)	Serial I/O output valid time	-30			ns		
tr(SCLK)	Serial I/O clock output rising time			50	ns		
tf(SCLK)	Serial I/O clock output falling time			50	ns		
tr(CMOS)	CMOS output rising time (Note 1)		20	50	ns		
tf(CMOS)	AOS output falling time (Note 1) 20 50						

NOTE: 1. Pin XOUT is excluded.

### Switching characteristics (3)

(Vcc = 1.8 to 5.5 V, Vss = 0 V, Ta = -20 to 85 °C, unless otherwise noted)

Symbol	Deremeter		1.1		
	Parameter	Min.	Тур.	Max.	Unit
tWH(SCLK)	Serial I/O clock output "H" pulse width	tc(ScLк)/2–70			ns
twL(SCLK)	Serial I/O clock output "L" pulse width	tc(ScLк)/2–70			ns
td(SCLK-TXD)	Serial I/O output delay time			450	ns
tv(Sclĸ-TxD)	Serial I/O output valid time	-30			ns
tr(SCLK)	Serial I/O clock output rising time			70	ns
tf(SCLK)	Serial I/O clock output falling time			70	ns
tr(CMOS)	CMOS output rising time (Note 1)		25	70	ns
tf(CMOS)	CMOS output falling time (Note 1)		25	70	ns

NOTE:

1. Pin XOUT is excluded.



Fig 83. Switching characteristics measurement circuit diagram



Fig 84. Timing chart

#### PACKAGE OUTLINE



### **REVISION HISTORY**

### 7548 Group Datasheet

Rev.	Date		Description				
		Page	Summary				
1.00	Dec 28, 2006	-	First edition issued				
1.01	Dec 28, 2006	1	Key-on wakeup is changed.				
		14	Fig.12 is revised.				
		19	Fig.16 is revised.				
2.00	Mar 15, 2007	1	<ul> <li>FEATURES: "• LED output port" → "• LED direct drive port"</li> <li>"• Built-in high-speed on-chip oscillator" → "High-speed on-chip oscillator"</li> <li>"• Built-in low-speed on-chip oscillator" → "Low-speed on-chip oscillator"</li> <li>•Power dissipation; "TBD" → "30 mW"</li> </ul>				
		4	Table 1: I/O port P0₀-P0⁊; "LED direct drive ports" is added A/D converter; "8 channel" → "× 8 channel"				
		6	Table 2: P03 "Capture function pin" → "Capture input pin" P10-P12 "Compare function pin" → "Compare output pin" P13 "Timer 2 function pin" → "Timer 2 output pin" P20, P21 "external oscillator pin" → "clock pins"				
		10	[CPU mode register]: Description is revised and moved from the page 12.				
		11	Function set ROM Area: Description is revised and moved from the page 47. <li>Notes&gt;: (2) is added, (3) is revised</li>				
		12	Fig 8 Note is deleted				
		14	Fig 10, Fig 11, Fig 12 is moved from the page 47. Fig 12 is revised				
		15	[Pull-up control registers]: Description revised Fig 13, Fig 14, Fig 15 is revised				
		16	Table 6 is revised				
		17, 18	Fig 17, Fig 18; Title is revised				
		19	Contents of Table 7 is added				
		21	Table 8: Key-on wakeup "P0" $\rightarrow$ "P1"				
		24	Timers, • Notes on Timers 1 and 2: Description is revised				
		26	Timer A (TA), • Notes on Timer A: Description is revised				
		27	Output compare: Contents of description added Fig 30 "oscillator/ <u>512</u> " $\rightarrow$ "oscillator/ <u>16</u> "				
		31	Input capture: Contents of description added				
		32	Fig 40 "oscillator/512" $\rightarrow$ "oscillator/16"				
		37, 38	register name: "A/D" $\rightarrow$ "AD"				
		38	Notes on A/D converter: (2) is added				
		39	Watchdog Timer is revised Fig 51, Fig 54 is revised				
		40	Notes on Watchdog Timer is revised				
		42	Fig 57 is revised				
		43	Clock Circuit is revised				
		44	Oscillation Control is added Table 9 is added Fig 62 is revised				
		47	Fig 63 is revised				
		48	Fig 64 is revised				

REVISION HISTORY			7548 Group Datasheet
Rev.	Date		Description
		Page	Summary
2.00	Mar 15, 2007	49	"oscillation stop" → "oscillation stop detection" Fig 65 is revised Fig 66 is revised, Note 4 is added • Notes on Function Set ROM Data 2 is deleted
		50	Table 10: P1o "ESDA input" $\rightarrow$ "ESDA I/O", "Output" $\rightarrow$ "I/O"
		53	(7) CPU Mode Register is revised
		58	Overvoltage: Description revised, Fig 80 is added
		59	ELECTRICAL CHARACTERISTICS is added
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